

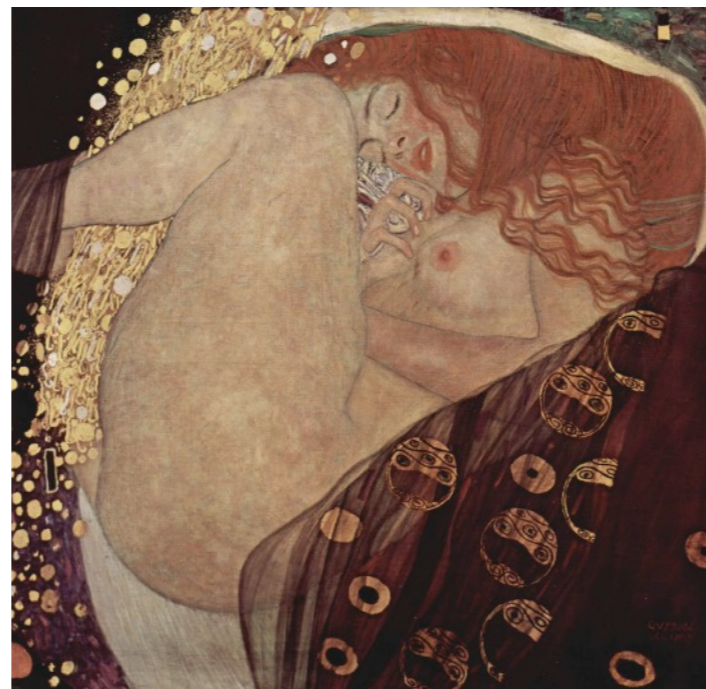
DANAE - a new experiment for direct dark matter detection using RNDR DEPFET detectors

Hexi Shi
HEPHY ÖAW

DANAE (DANAË)

Direct dArk matter search using DEPFET with repetitive- Non-destructive-readout Application Experiment

OeAW funding for detector technology



“Danae” by G. Klimt

Collaboration

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H. Kluck ^{B,C}, J. Schieck ^{B,C}, H. Shi ^B,



Max-Planck-Gesellschaft Halbleiterlabor, Germany ^A,

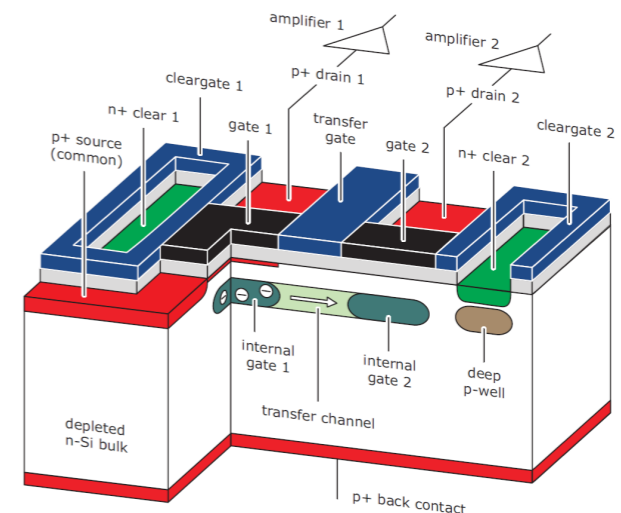
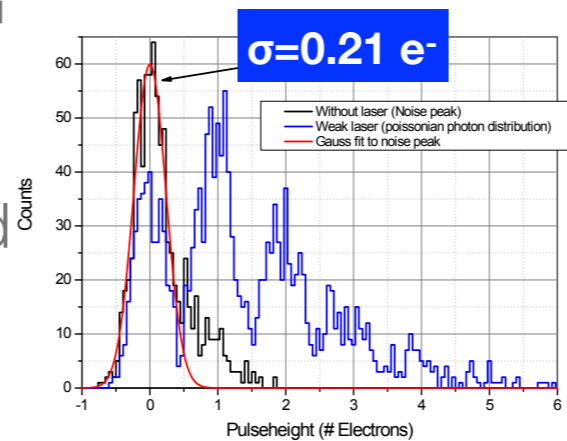
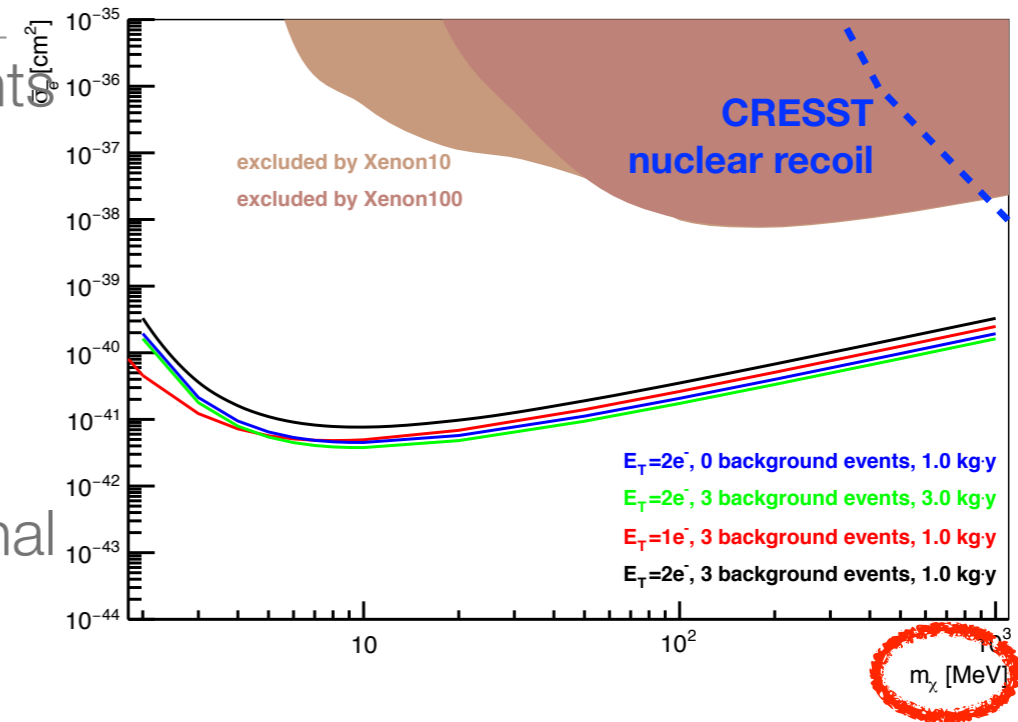
Institut für Hochenergiephysik der Österreichischen Akademie der Wissenschaften, Vienna, Austria ^B,

Atominstytut, Technische Universität Wien, Vienna, Austria ^C

The project overview

Direct Dark Matter Detection with DEPFET

- minimal reach for nuclear recoil experiments about few 100 MeV
- dark matter electron scattering offers **reach towards MeV dark matter**
- measurement of **low noise** ionisation signal in **low background** environment
- RNDR* DEPFET sensors developed by semiconductor laboratory of MPG
- setup for **proof-of-principle measurement** currently prepared
- expect first results early 2019**

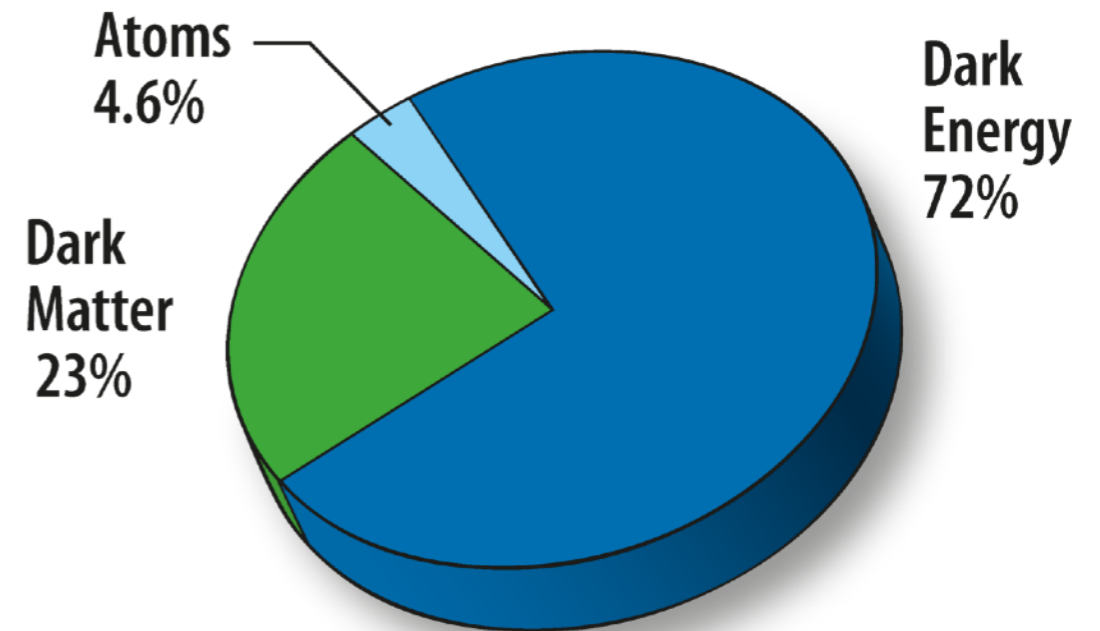


EPJ C, 77(12), 279 (2017)

*Repetitive Non-Destructive Readout

Dark matter landscape - partly

Over 80% of the mass in the universe is invisible dark matter



TODAY

Credit: NASA / WMAP Science Team

“WIMP” as a dark matter candidate :

- weakly interacting with matter

$$\langle \sigma_{\text{WIMP}} \cdot v \rangle \sim G_F^2 \cdot m_X^2 \sim 1/\Omega_X$$

- fits the Hubble constant and “relic” density of dark matter

predicts dark matter WIMP mass between 2 GeV and 120 TeV



WIMPs

dominated the direct detection experiments until recently

WIMP direct detection method

look for nuclear recoils from
WIMP-nucleus scattering

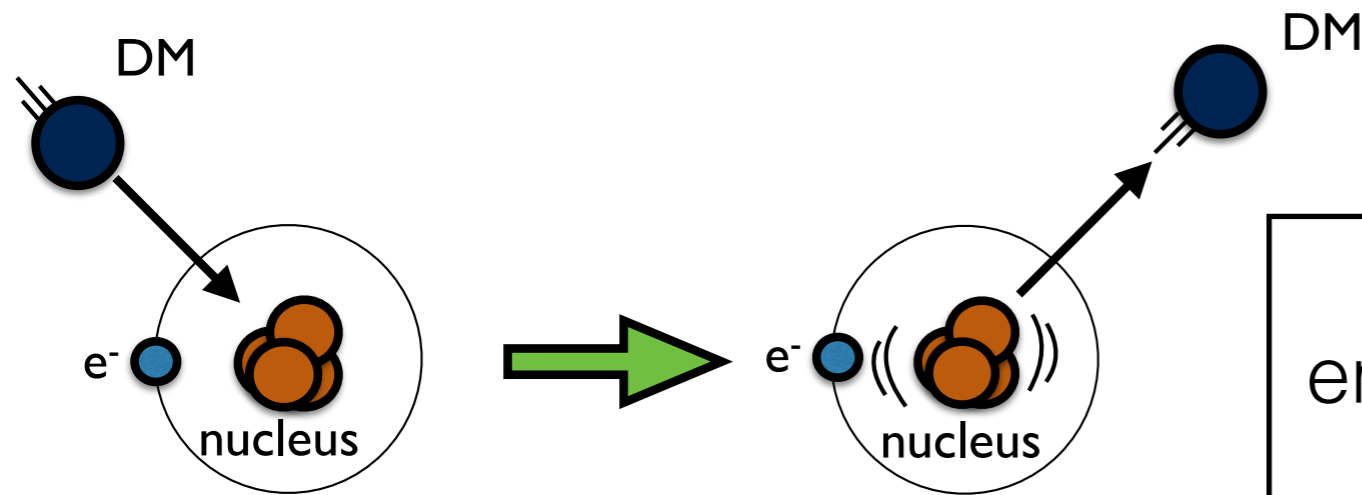


image credit R. Essig

Energy deposit in target
material in forms of :

- light
- phonon
- electric charge

Detection limitation :
energy deposit from nucleus recoil
 $E_{NR} \sim 2\mu_{\chi,N}^2 \cdot v_{\chi}/m_N$

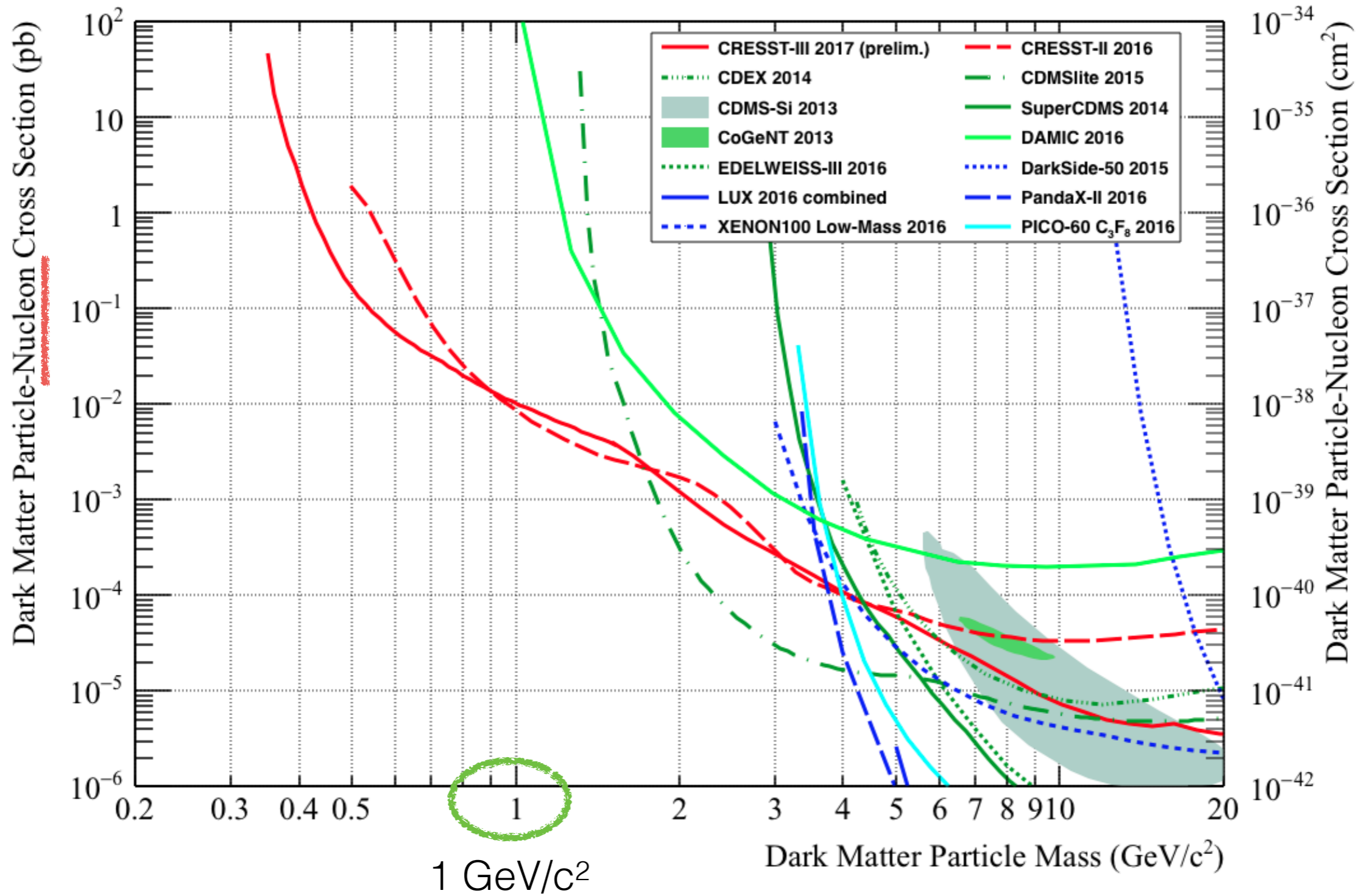
-> for 100 MeV m_{χ} , $E_{NR} \sim 1 \text{ eV}^*$

plus quenching factors and
noise level of the detectors

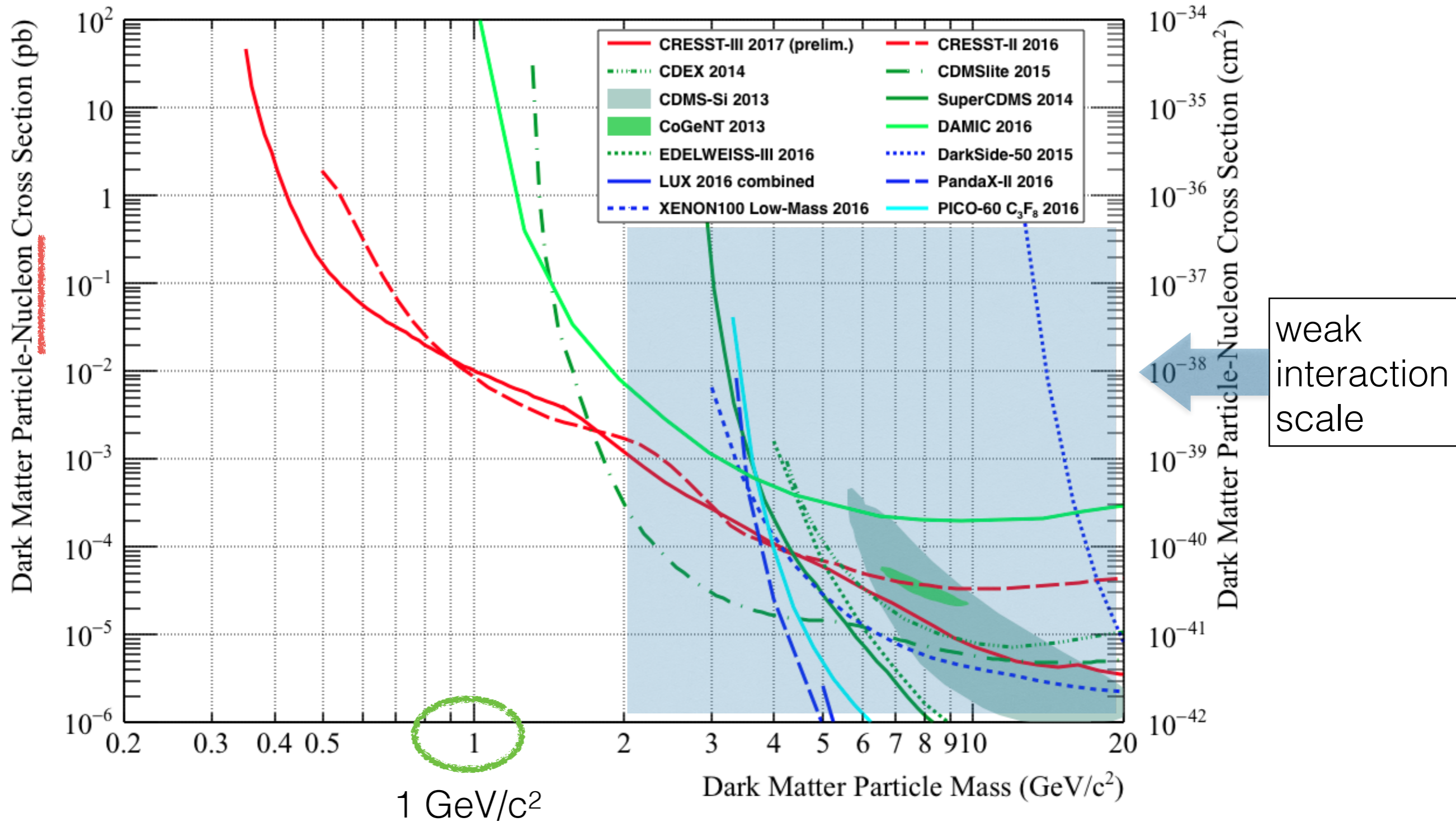
typical DM velocity $v_{\chi} \lesssim 800 \text{ km/s}$

*for silicon

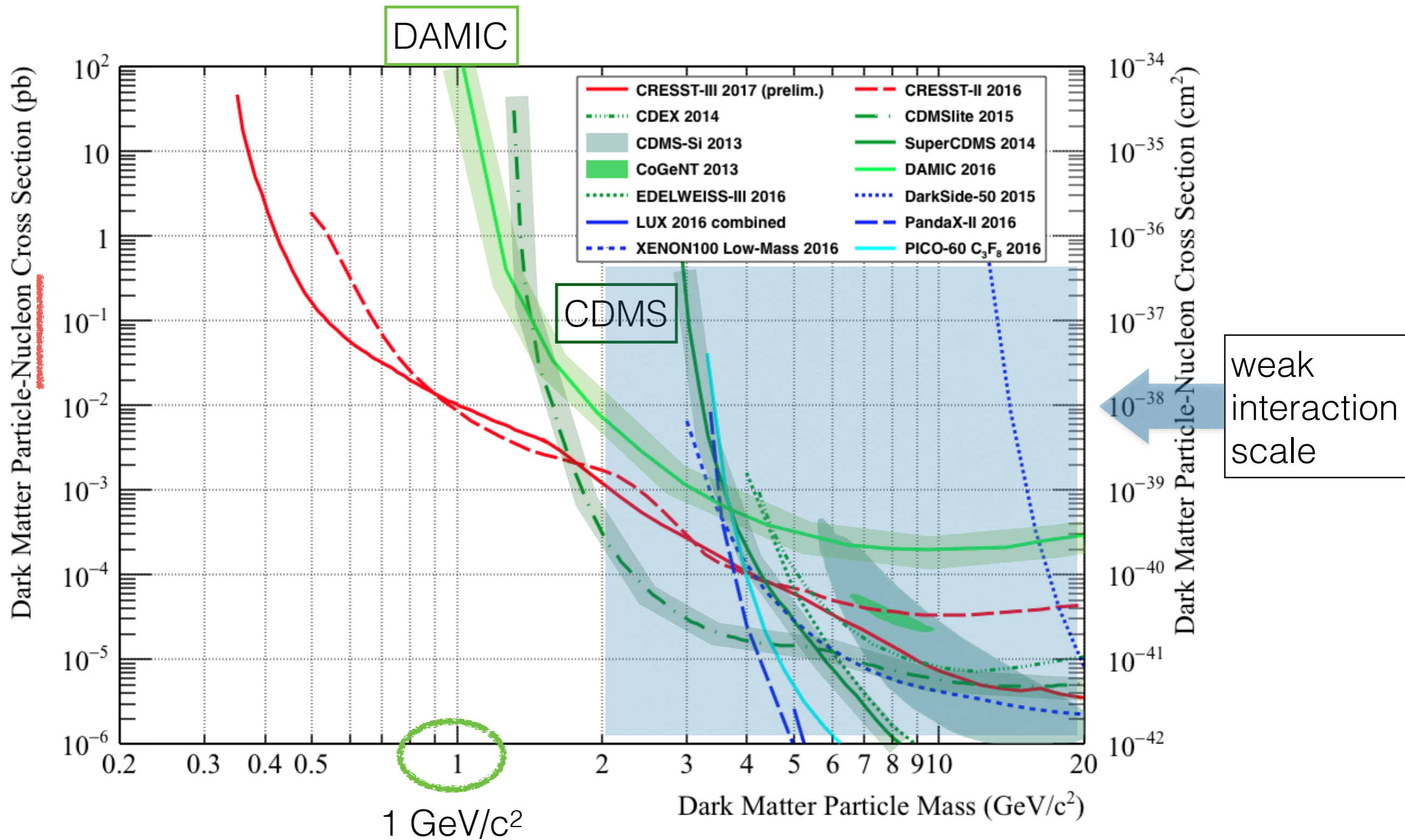
DM-nucleus scattering direct search status



DM-nucleus scattering direct search status



DM-nucleus scattering direct search status



Dark Sector and Light Dark Matter

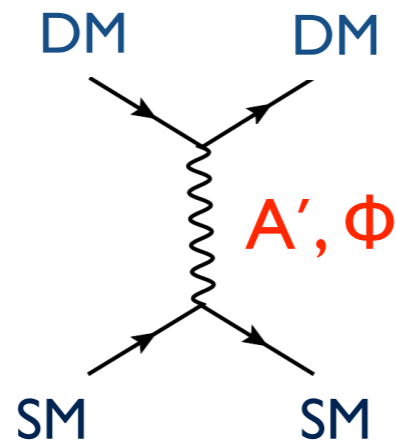


Dark sectors
(DM + new mediators)

WIMPs

several sharp “theory” targets
(freeze-out, asymmetric, freeze-in, SIMP, ELDER)

Dark sector :
interaction between DM and
standard model particle
mediated by a dark photon
(one example of mediators)



DM scattering

clear predictions from
multiple models over wide
DM mass region, including
keV ~ GeV range
-> comparable observables
in experiments

image credit R. Essig

DM-electron scattering

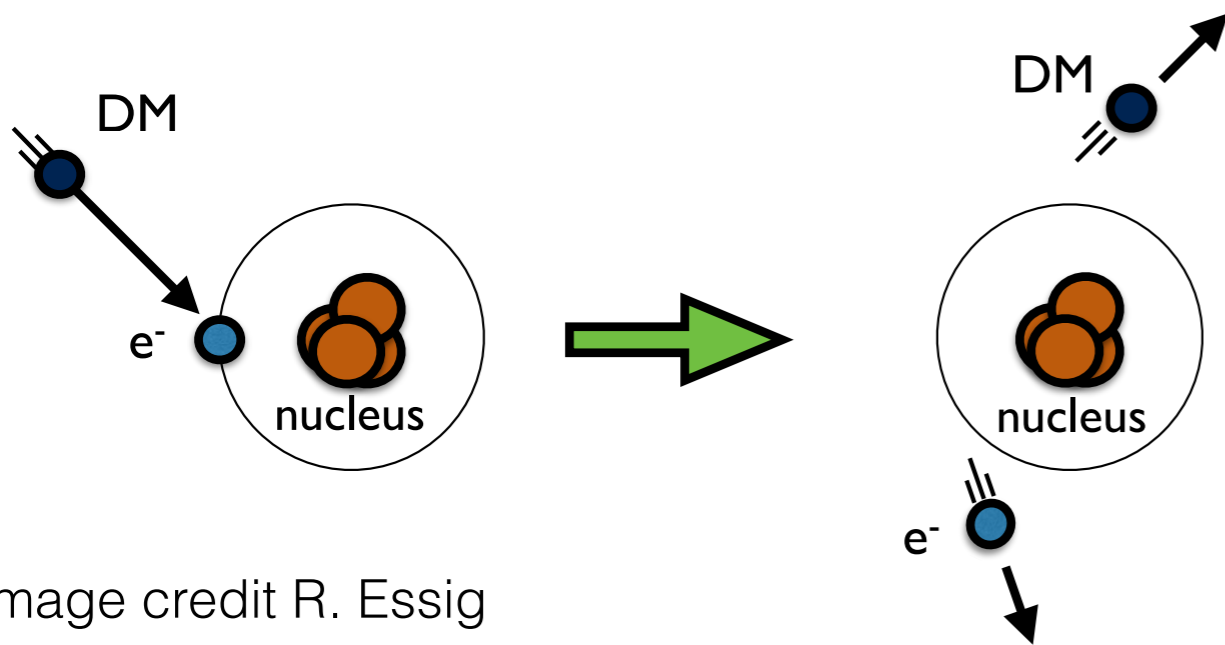


image credit R. Essig

kinematically

to overcome binding energy ΔE

$$\text{need } E_{\text{DM}} \sim \frac{1}{2} m_{\text{DM}} v_{\text{DM}}^2 > \Delta E$$

$$v_{\text{DM}} \lesssim 800 \text{ km/s} \implies m_{\text{DM}} \gtrsim 300 \text{ keV} \left(\frac{\Delta E}{1 \text{ eV}} \right)$$

O(100 keV)

DM-electron scattering

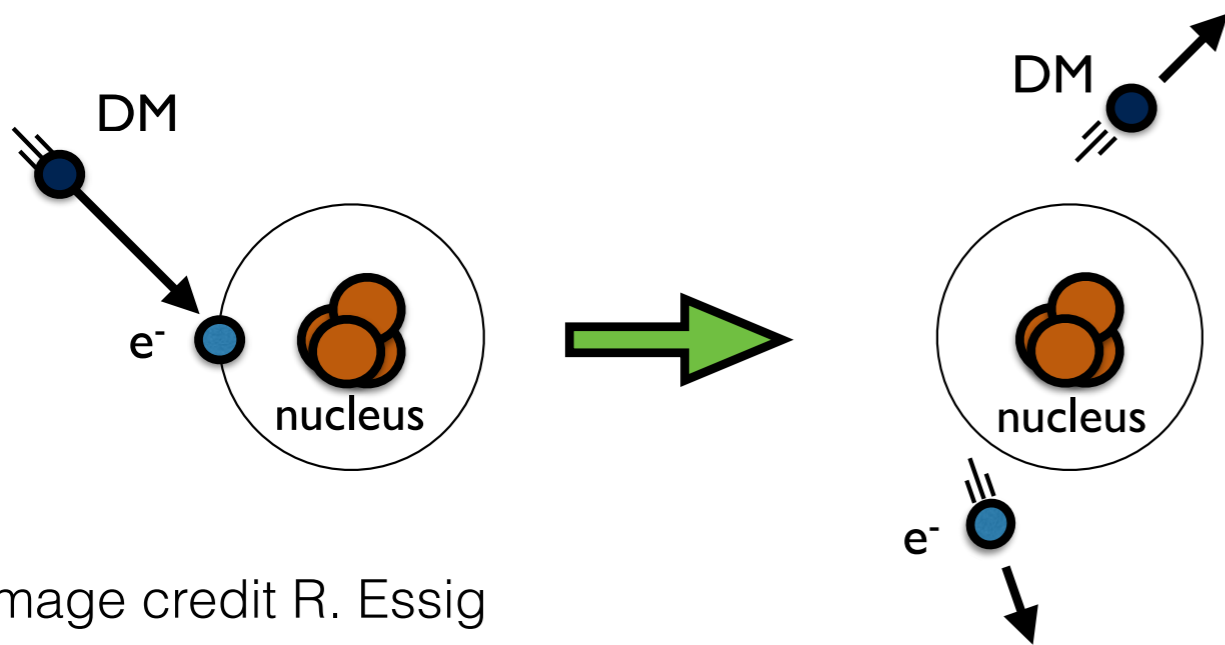


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kinematically

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O(100 keV)

bound e- does not have definite momentum,
typical momentum transfer is set by e- not by DM.

$q_{\text{typ}} \sim \alpha m_e \sim 4 \text{ keV}$

(for outer shell electron)

transferred energy: $\Delta E_e \sim \vec{q} \cdot \vec{v}_{\text{DM}}$

$\Delta E_e \sim 4 \text{ eV}$

typical
recoil energy

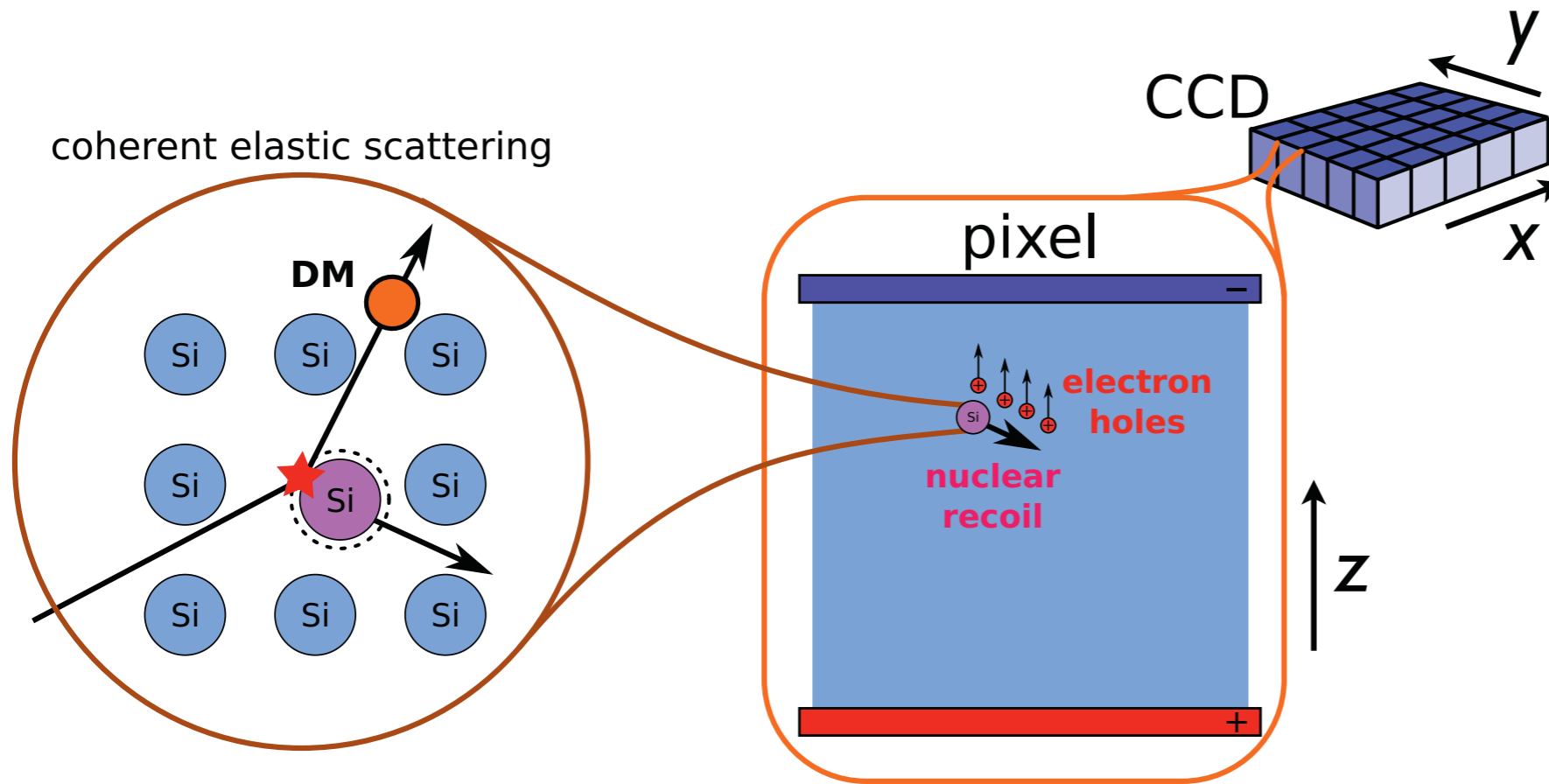
Target materials for electron recoils

Target Type	Examples	E_{th}	m_χ threshold	Status	Timescale
Noble liquids	Xe, Ar, He	~ 10 eV	~ 5 MeV	Done w data; improvements possible	existing
Semi-conductors	Ge, Si	~ 1 eV	~ 200 keV	($E_{\text{th}} \sim 40$ eV SuperCDMS, DAMIC) $E_{\text{th}} \sim 1$ eV SENSEI , DEPFET R&D	~ 1 -2 years
Scintillators	GaAs, NaI, CsI, ...	~ 1 eV	~ 200 keV	R&D required	$\lesssim 5$ years
Superfluid	He	~ 1 eV	~ 1 MeV	R&D required unknown background	$\lesssim 5$ years
Super-conductor	Al	~ 1 meV	~ 1 keV	R&D required unknown background	$\sim 10 - 15$ years

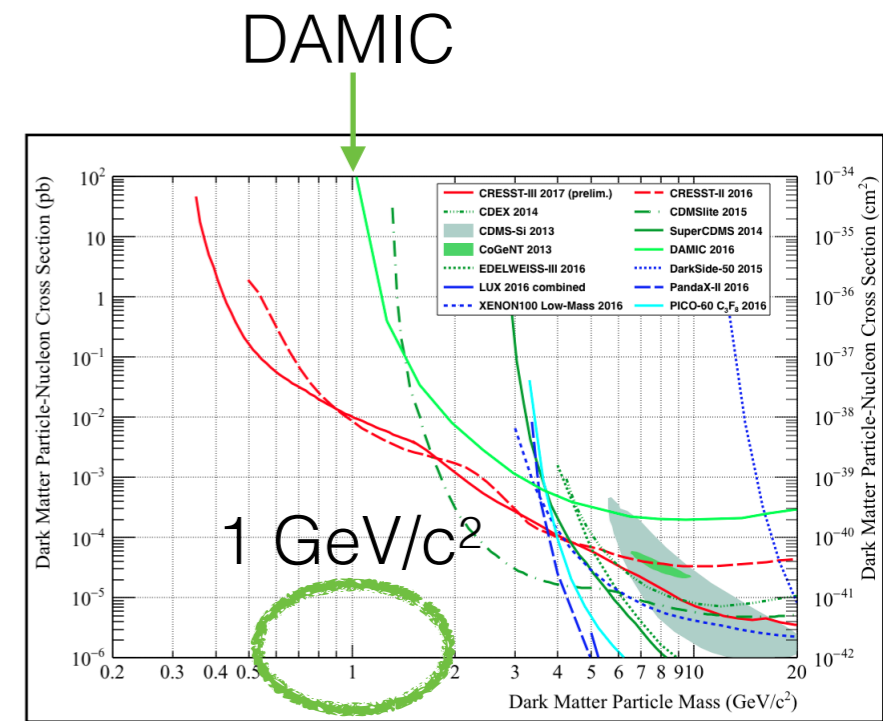
Application of Silicon detector

DAMIC

nucleus recoil CCD, with physics results



Physics Procedia 61 (2015) 21 – 33

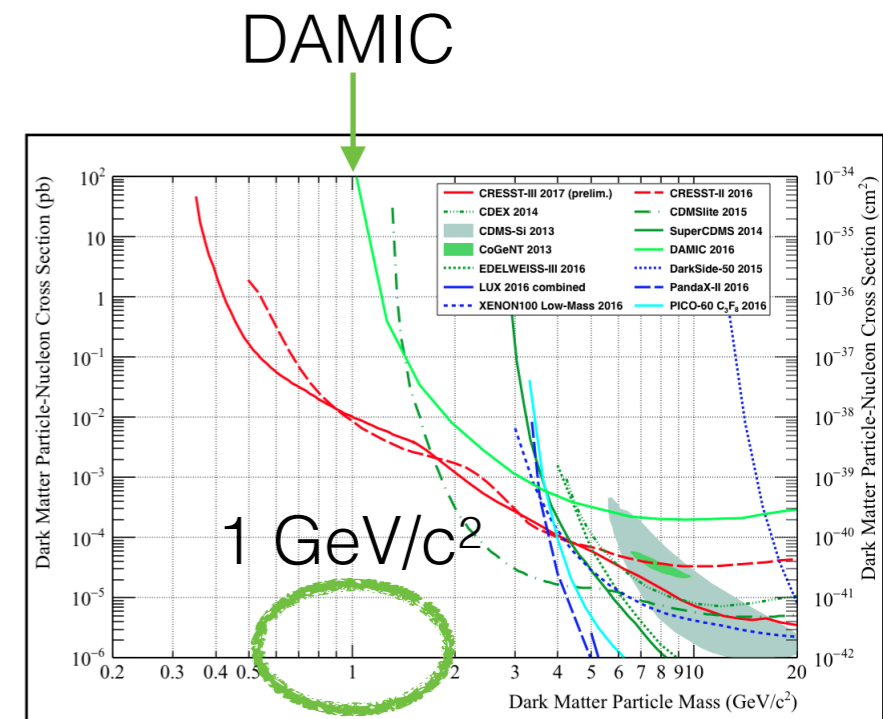
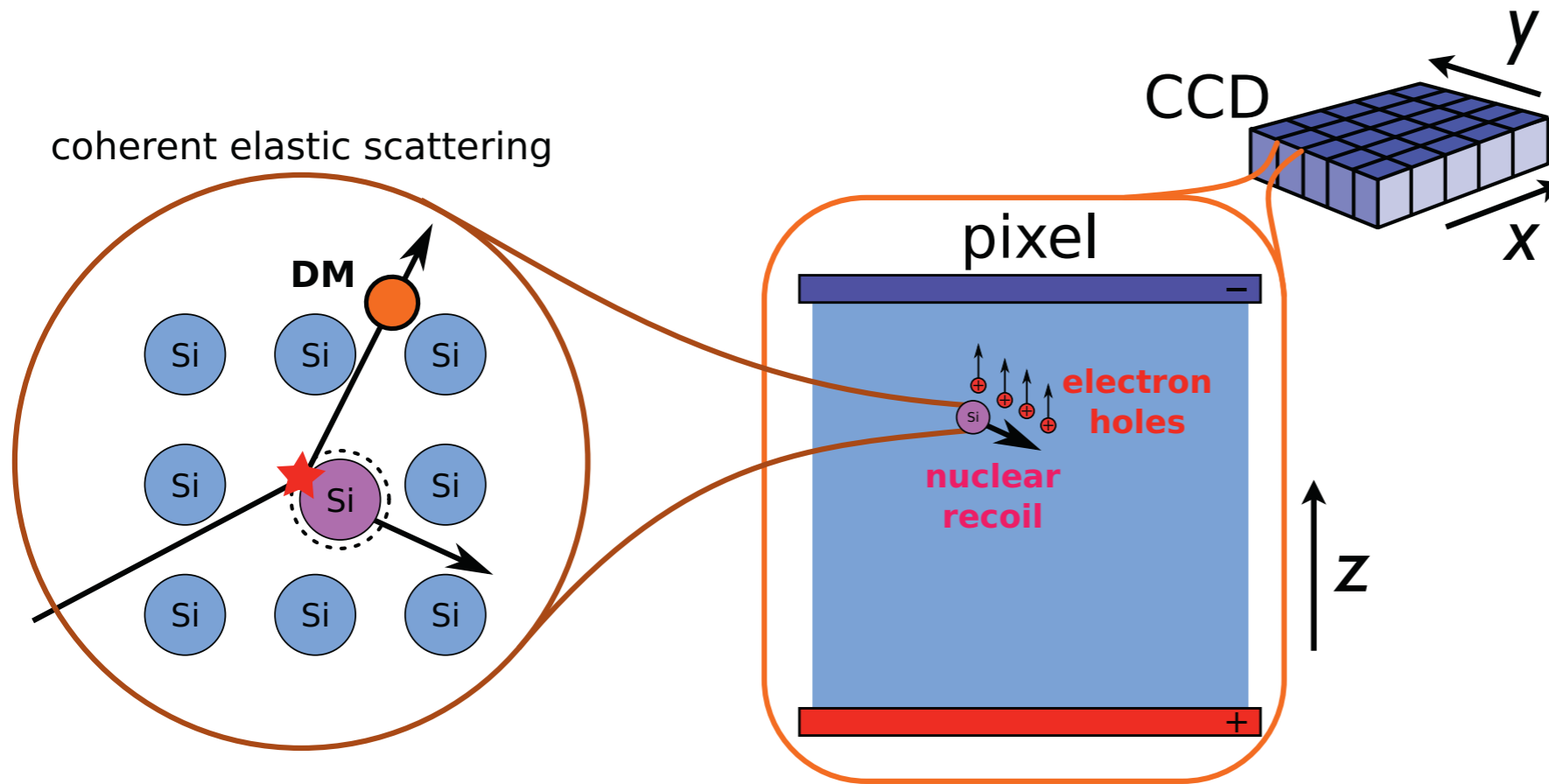


Readout noise determines threshold of $\sim 11 e^-$
(or $\sim 40 eV$)

Application of Silicon detector

DAMIC

nucleus recoil CCD, with physics results

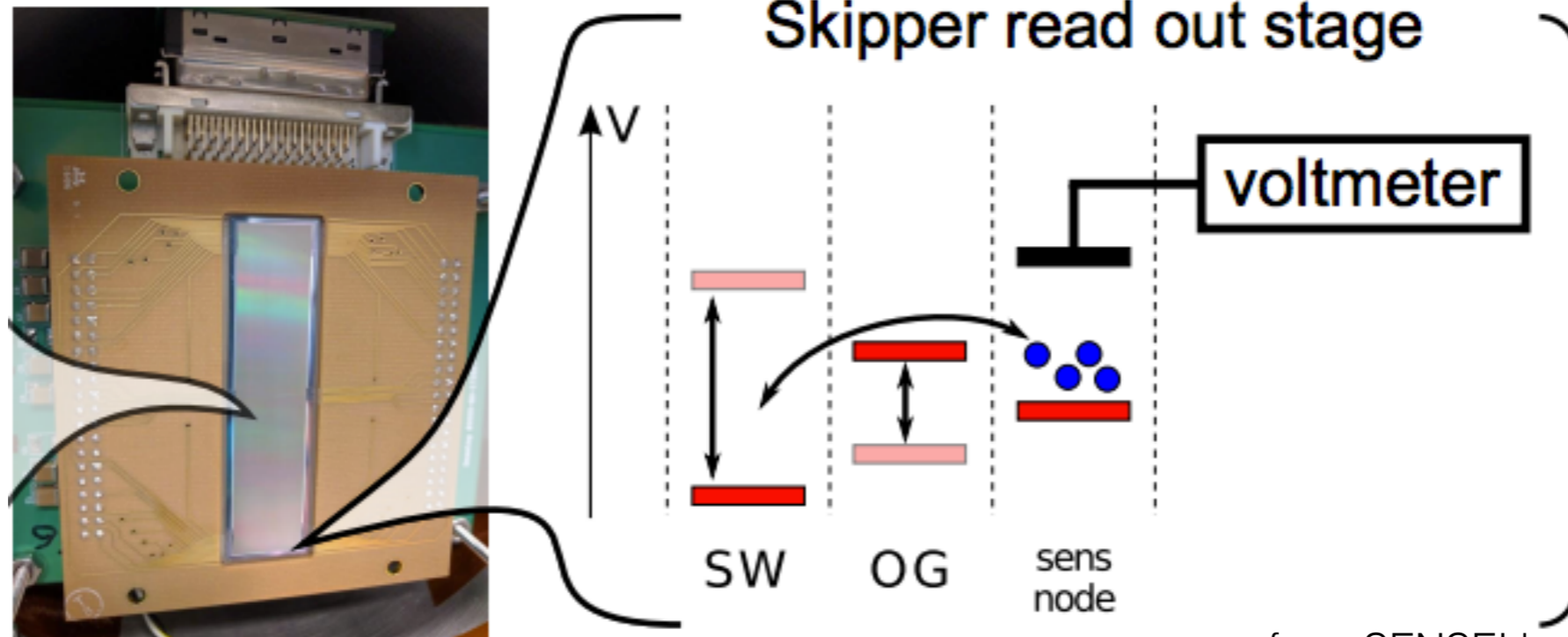


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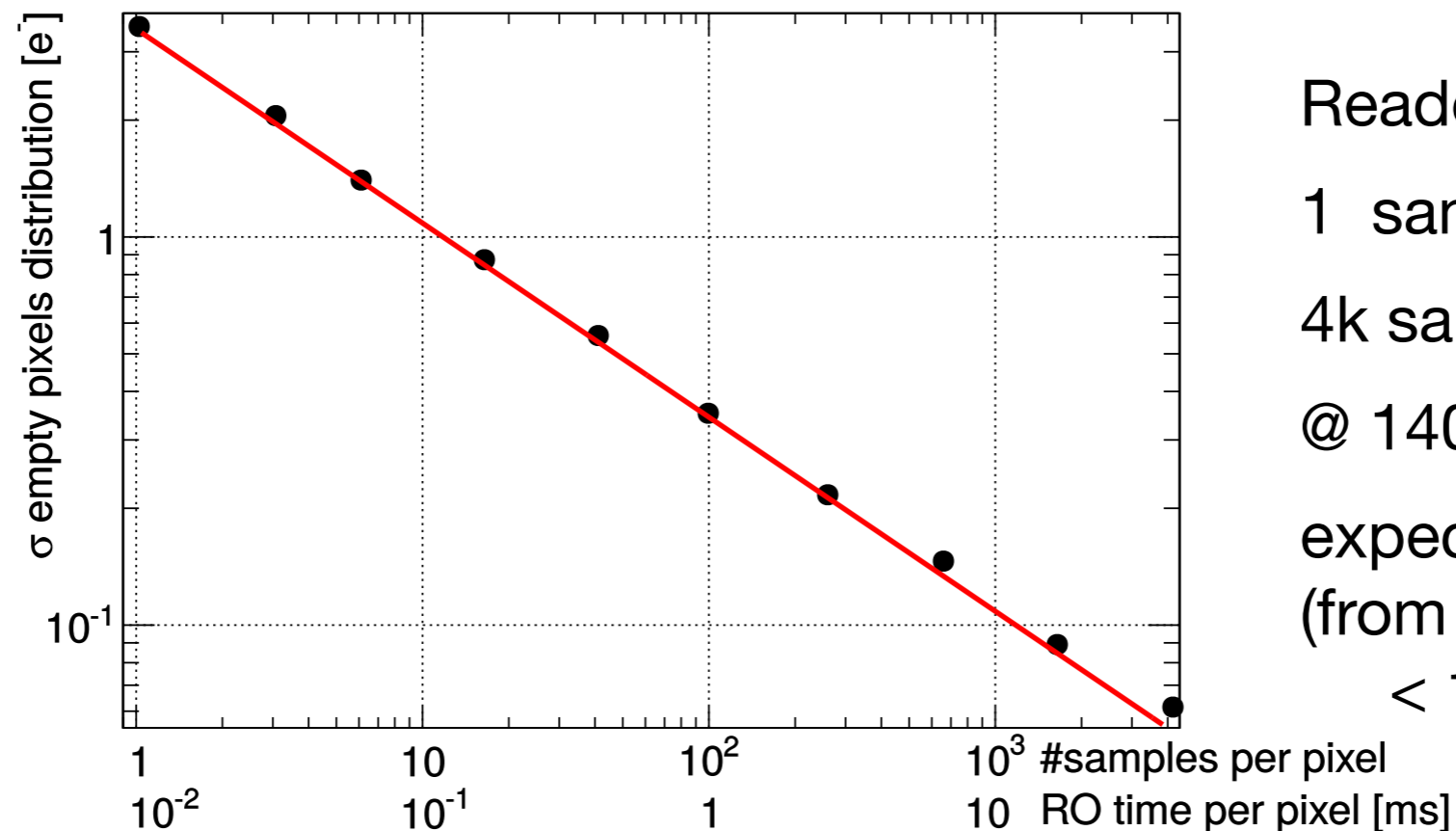
For $O(\text{MeV})$ DM-electron scattering, required threshold : $O(e^-)$
Sub-electron noise level necessary

Skipper CCD for SENSEI

DAMIC CCD with repetitive readout



from SENSEI homepage



Readout noise :

1 sample : 3.55 e⁻ rms

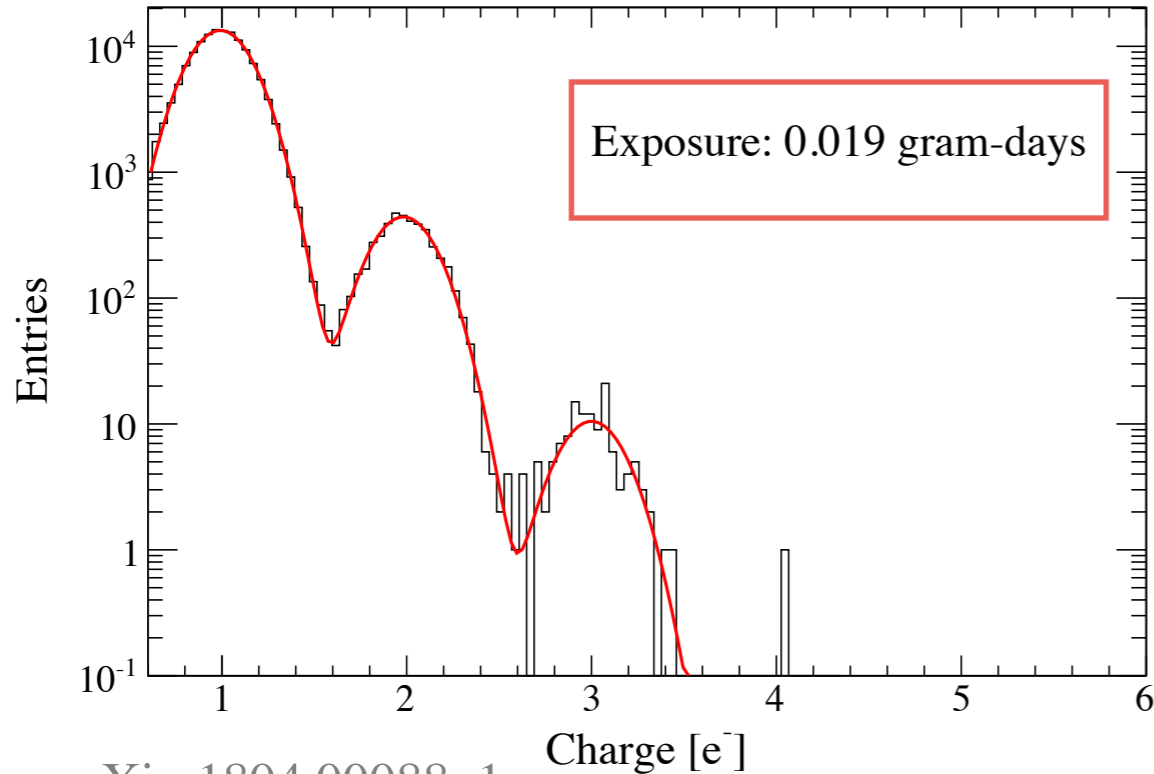
4k samples : 0.068 e⁻ rms

@ 140 K

expected dark current
(from DAMIC CCD) :

< 10⁻³ e⁻/pix/day

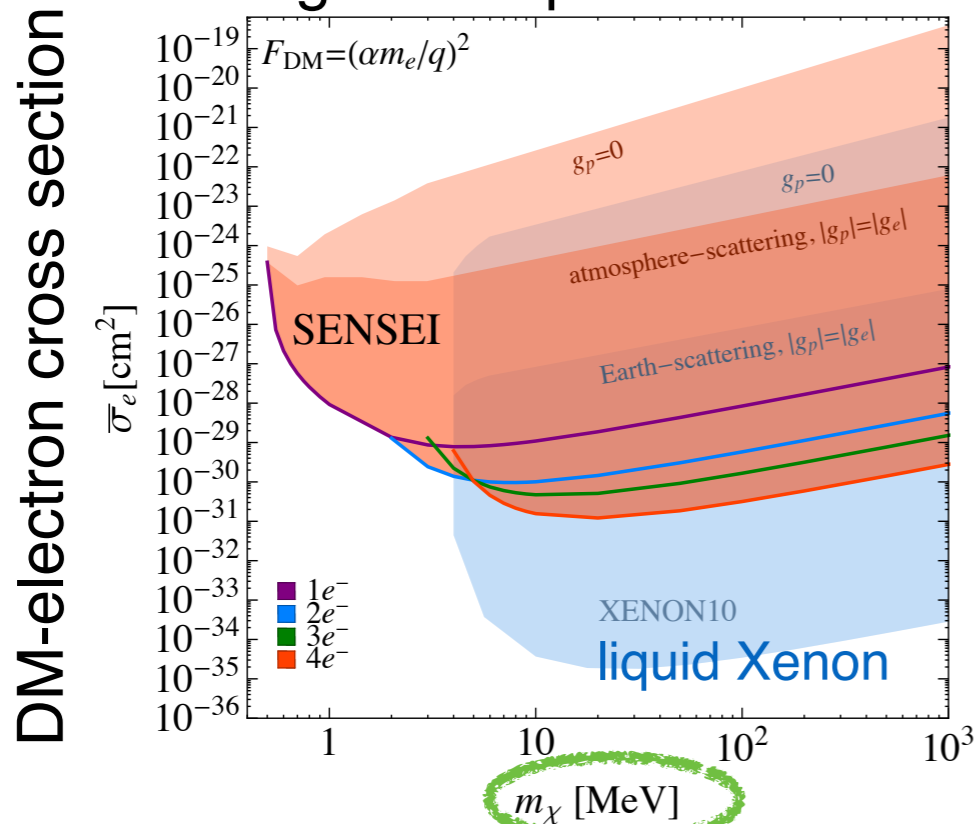
SENSEI first result from a surface run



arXiv:1804.00088v1

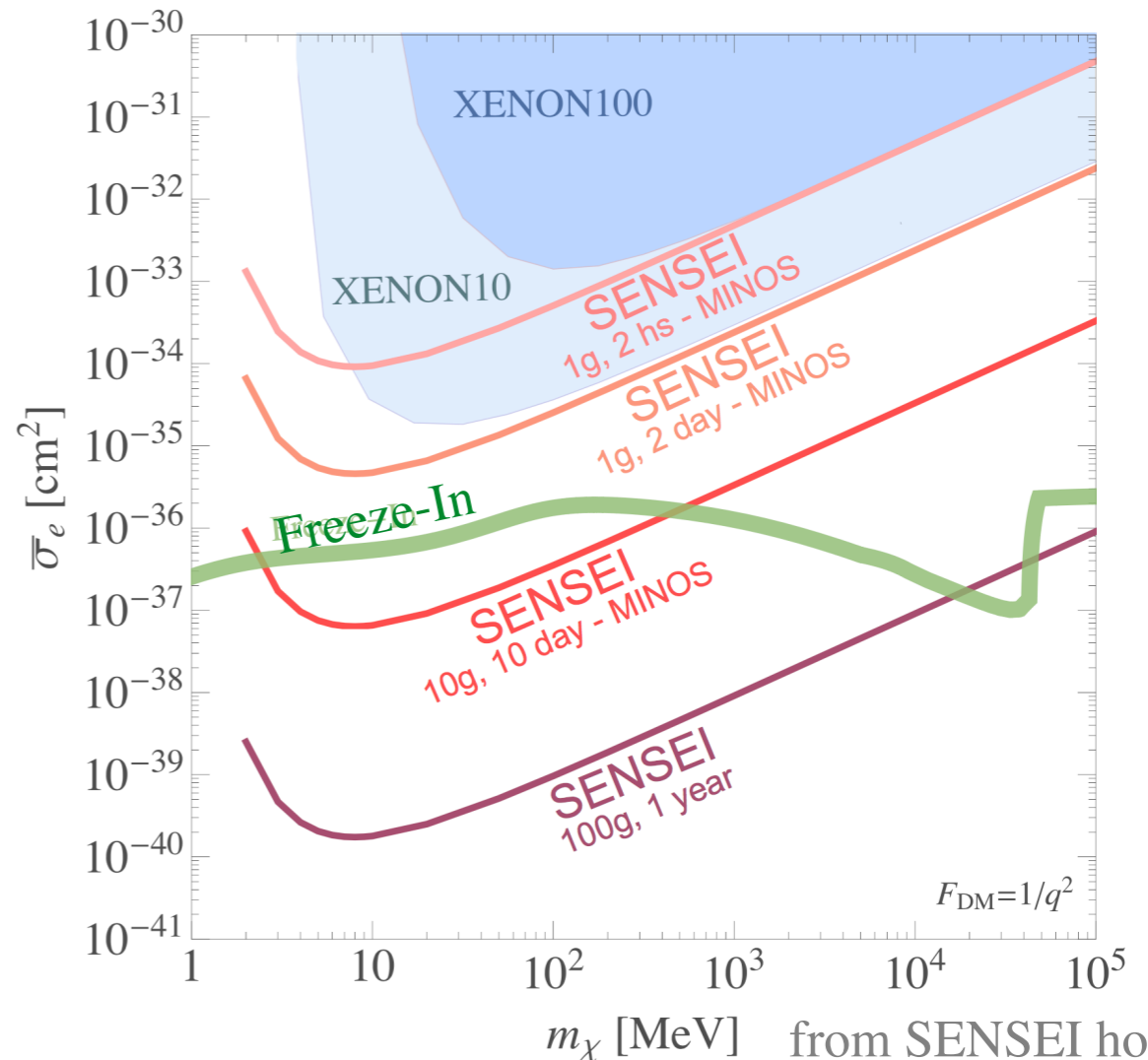
Active mass : 0.071 grams
 427 minutes exposure (0.33 g-hr)
 above sea level 220 m
 single read noise : $\sim 4 e^-$
effective noise : $\sim 0.14 e^-$ (800 repetitions)
dark current : $\sim 1.14 e^-/\text{pixel}/\text{day}$
 assume all events DM induced
 -> conservative limit

ultralight dark photon mediator



arXiv:1804.00088v1

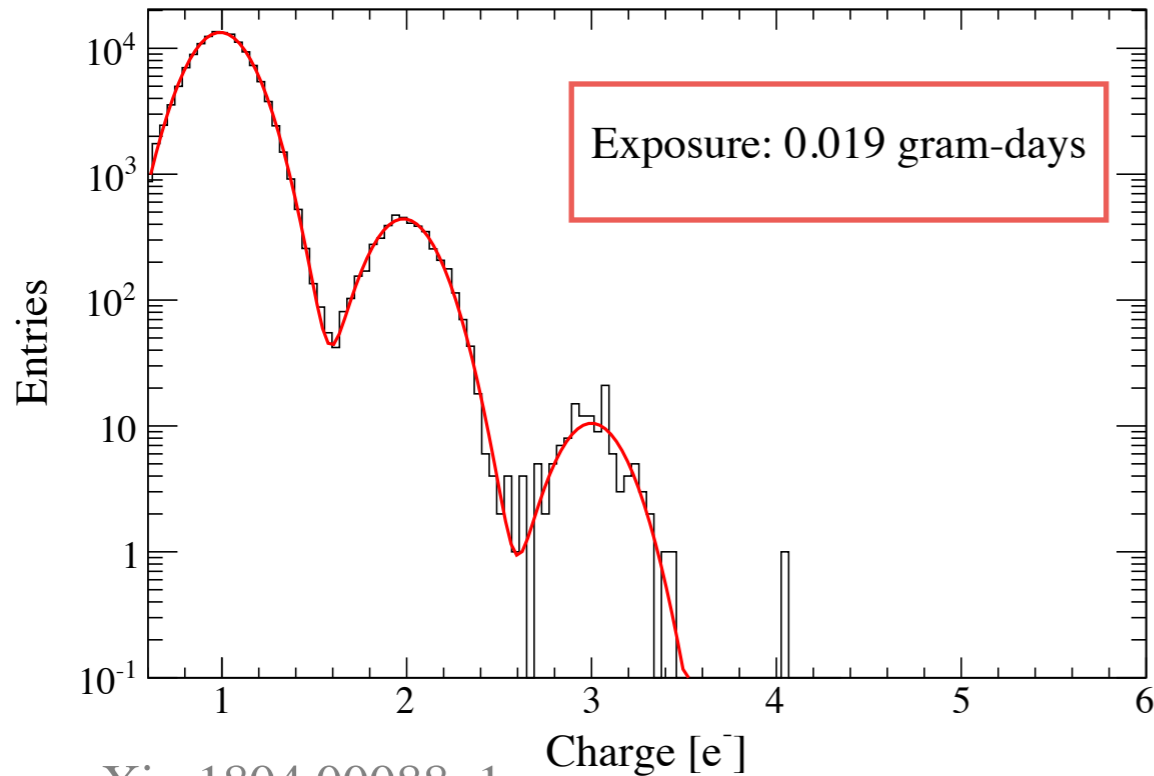
DM-electron cross section



12

from SENSEI homepage

SENSEI first result from a surface run

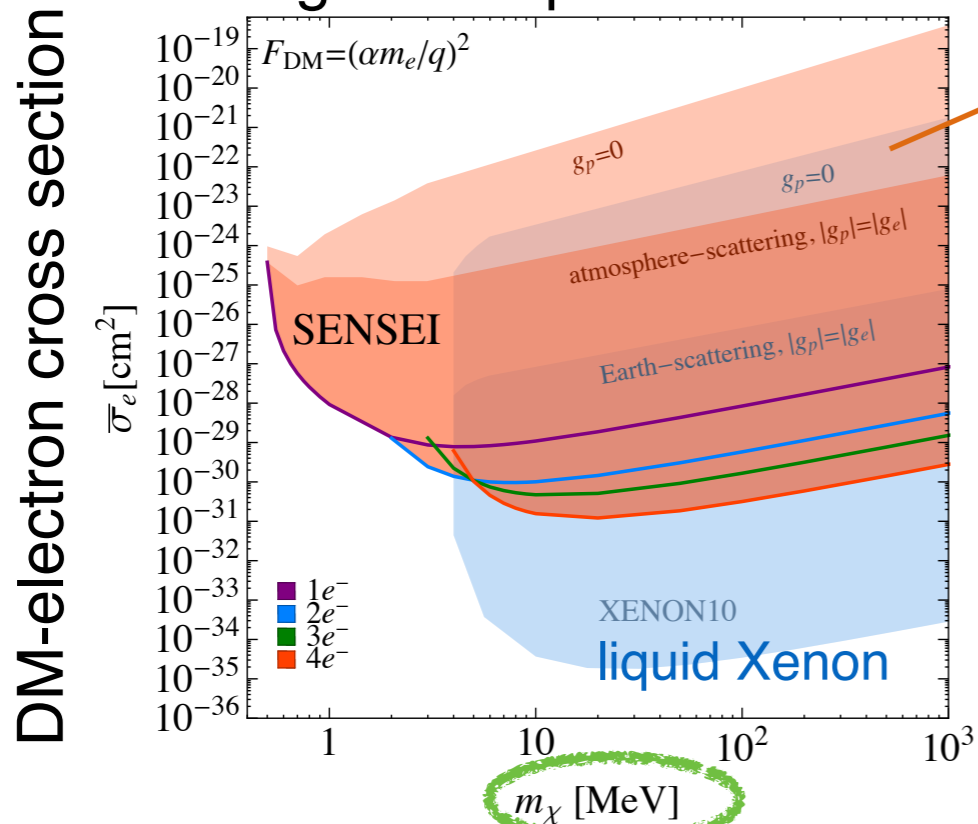


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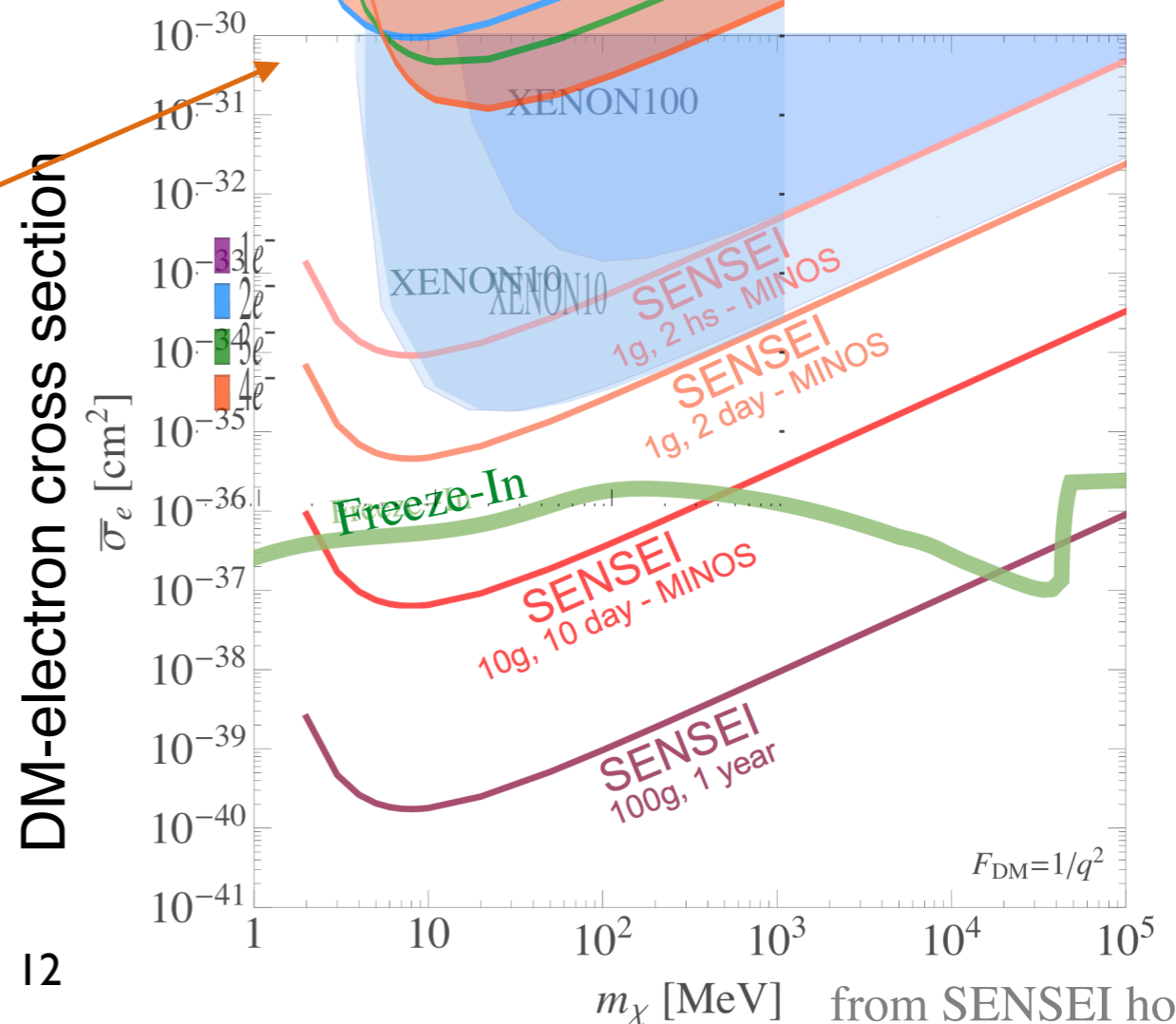
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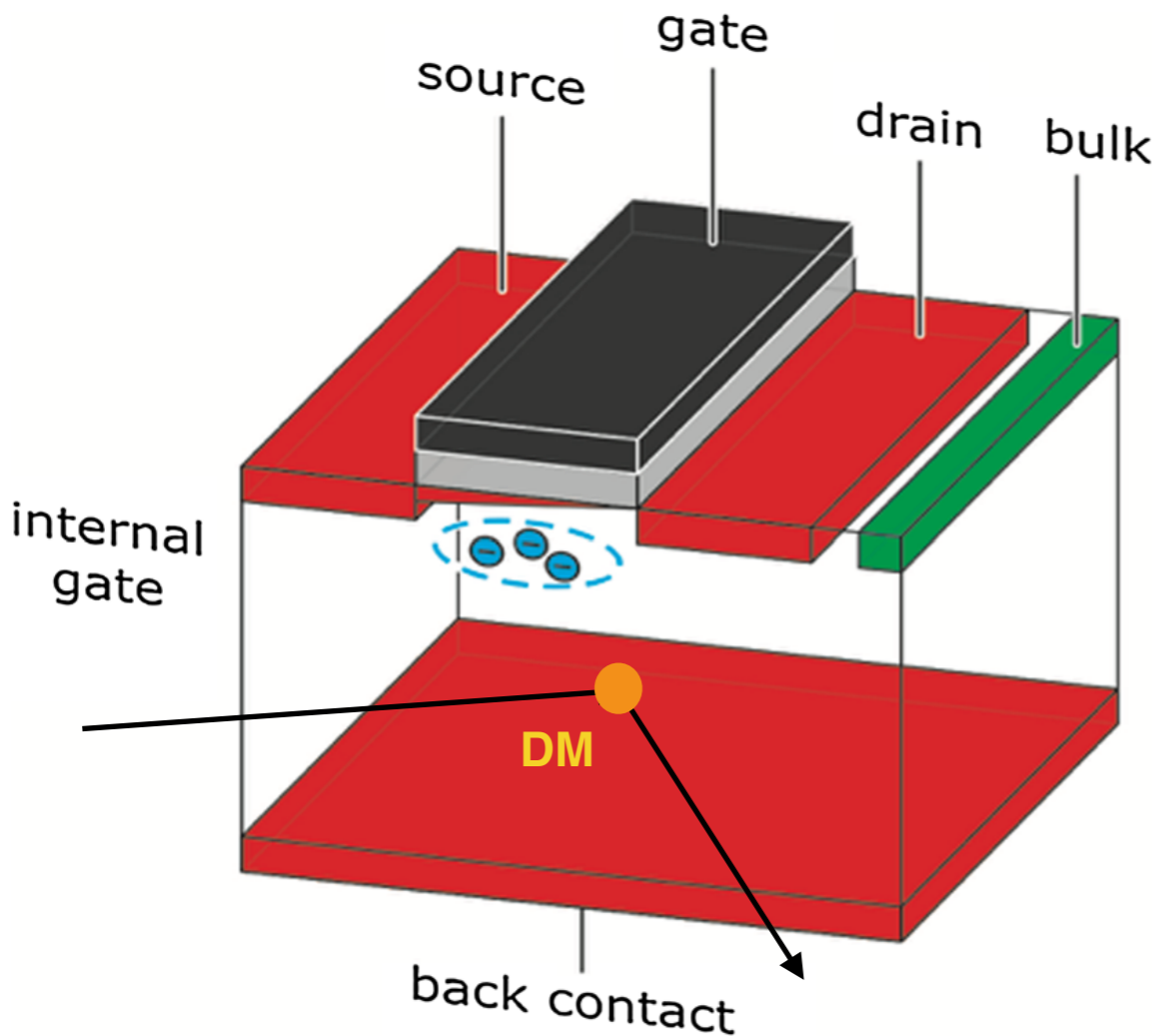
12

from SENSEI homepage

DEPFET with RNDR

RNDR : repetitive non-destructive readout

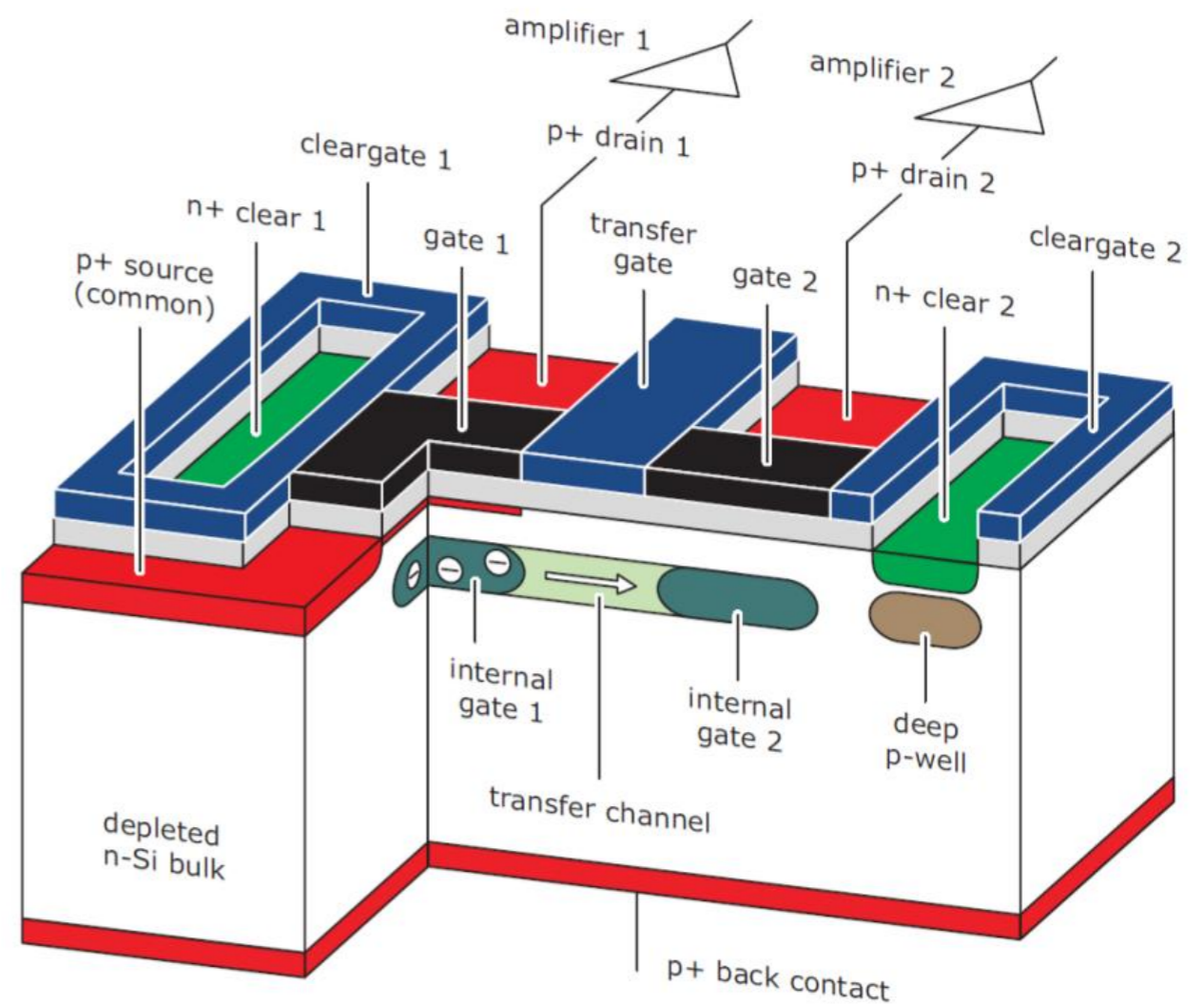
structure of a basic DEPFET cell :
a “subpixel”



EPJ C, 77(12), 279 (2017)

fully-depleted n-Si

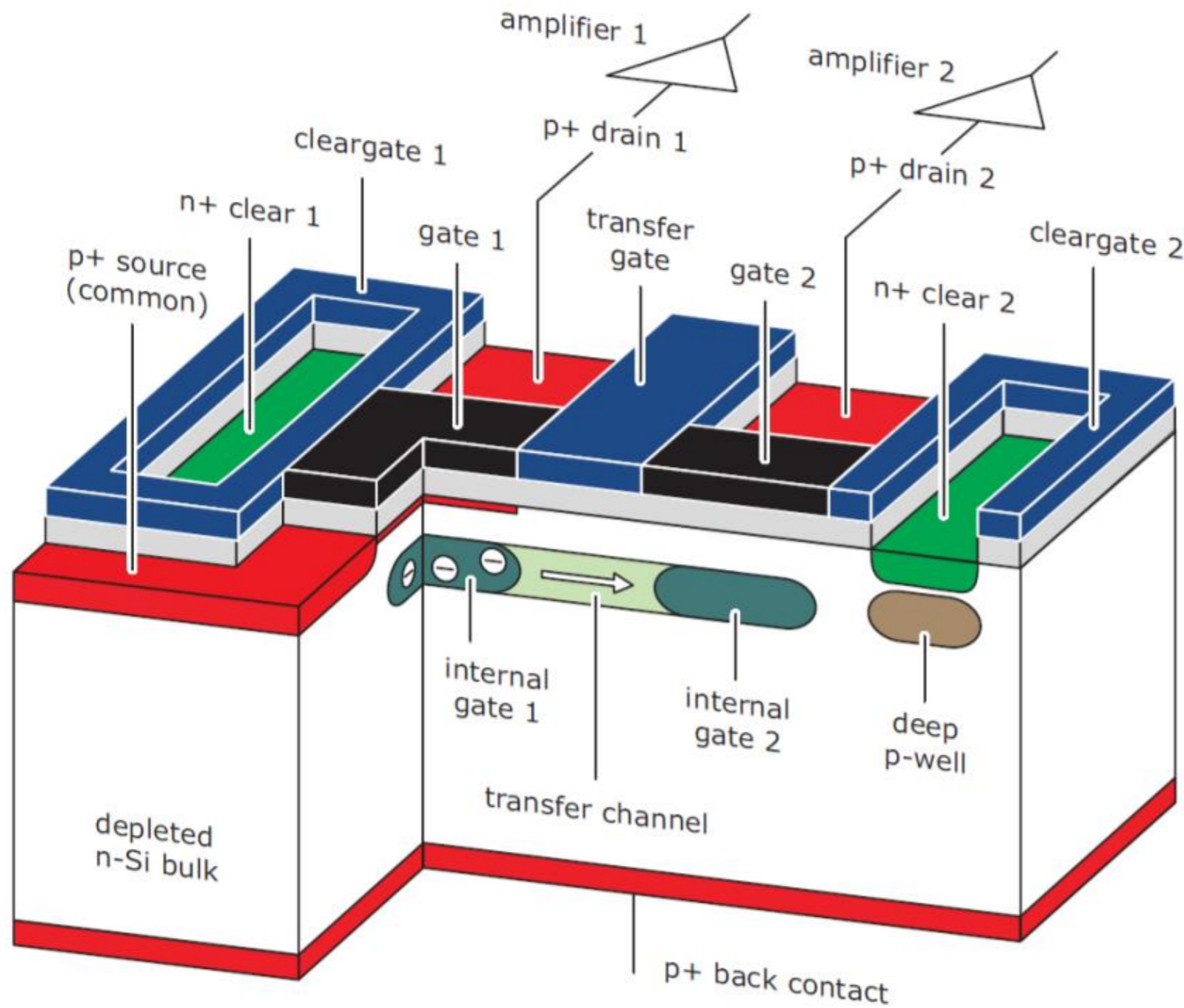
structure of RNDR DEPFET “super-pixel”



EPJ C, 77(12), 279 (2017)

RNDR

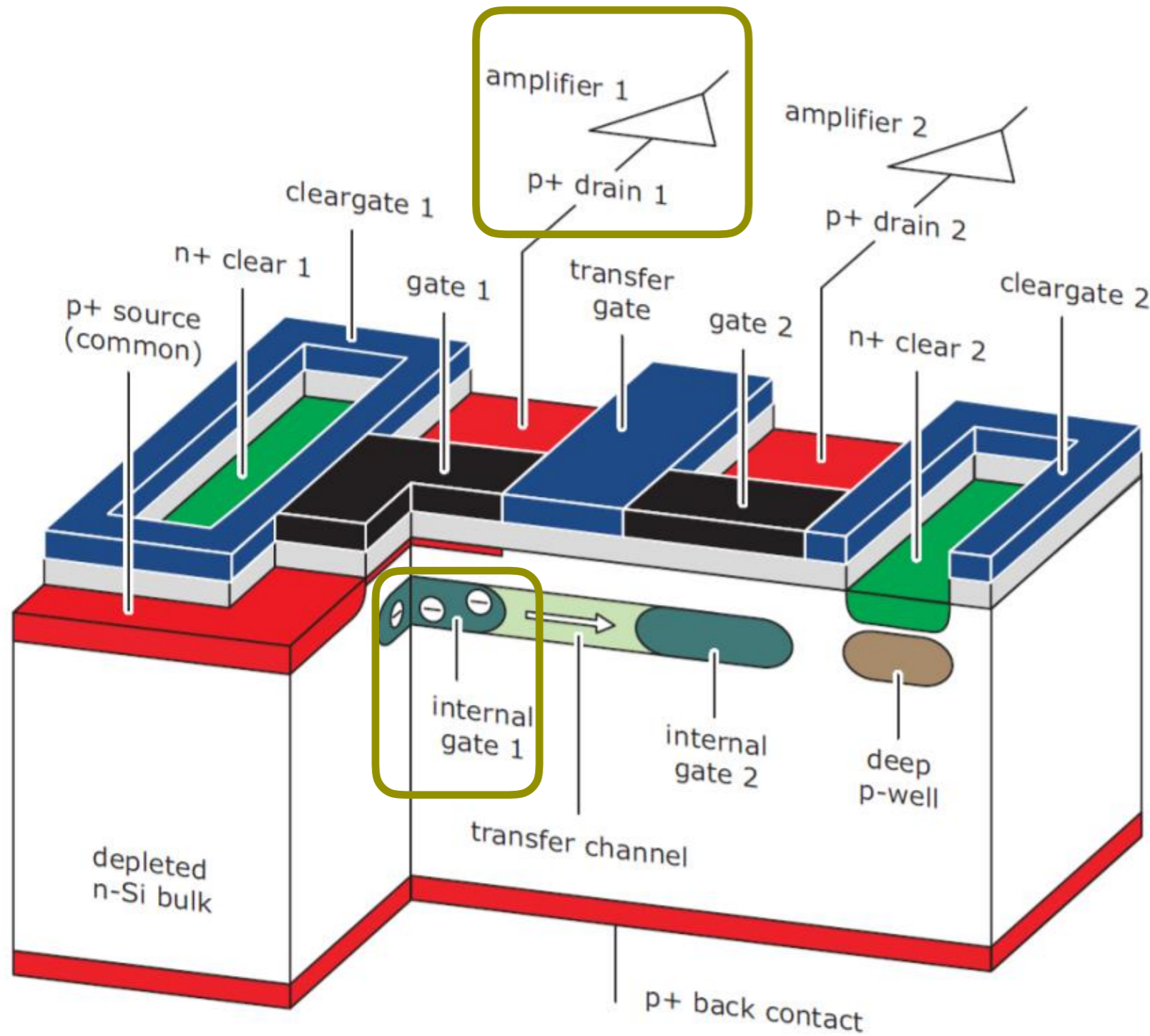
RNDR readout



EPJ C, 77(12), 279 (2017)

read N times effective noise :
 $\sigma_{\text{eff}} = \sigma / (\sqrt{N})$

RNDR



RNDR readout

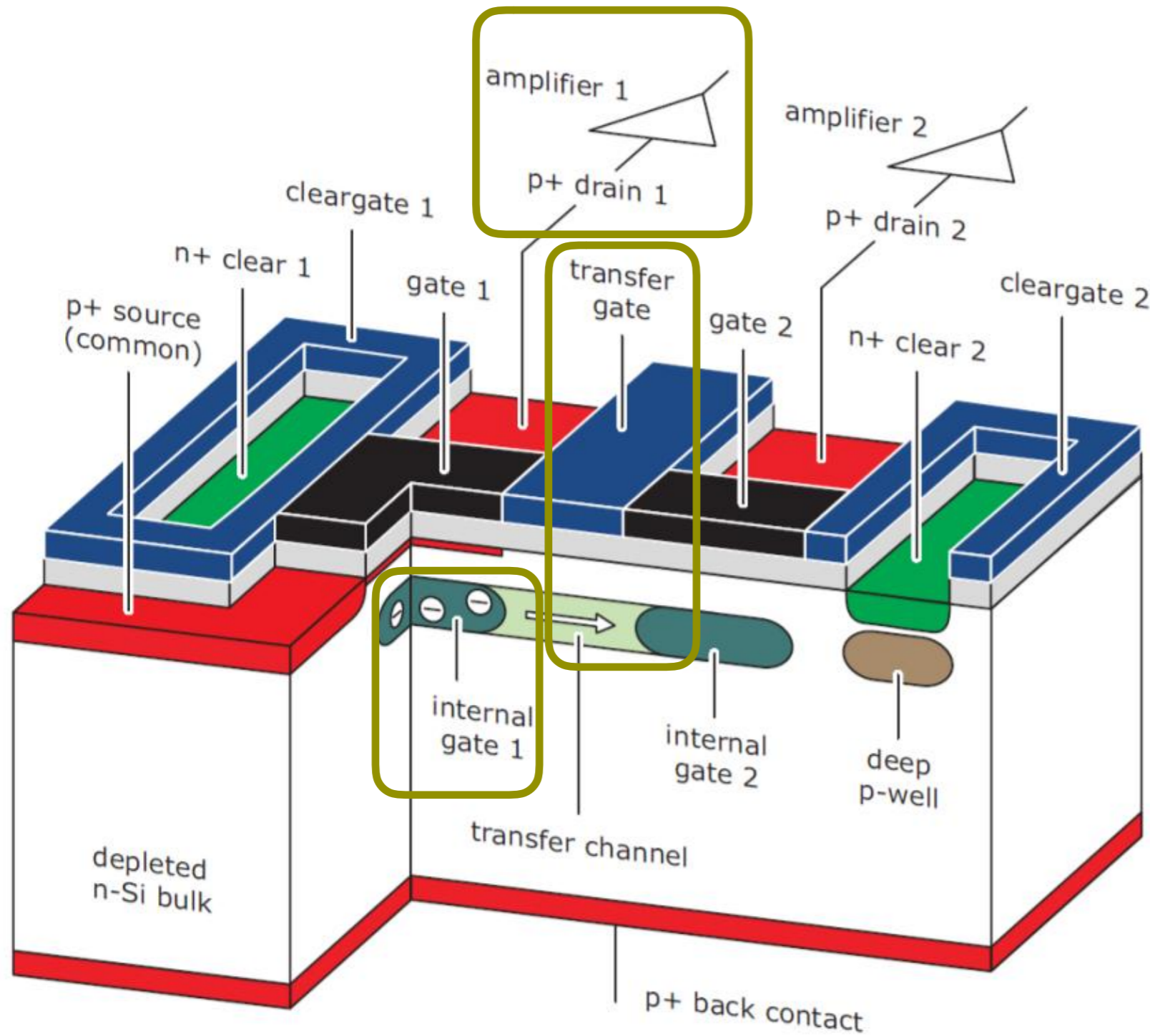
read 1 : noise σ

EPJ C, 77(12), 279 (2017)

read N times effective noise :

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RNDR



EPJ C, 77(12), 279 (2017)

RNDR readout

read 1 : noise σ

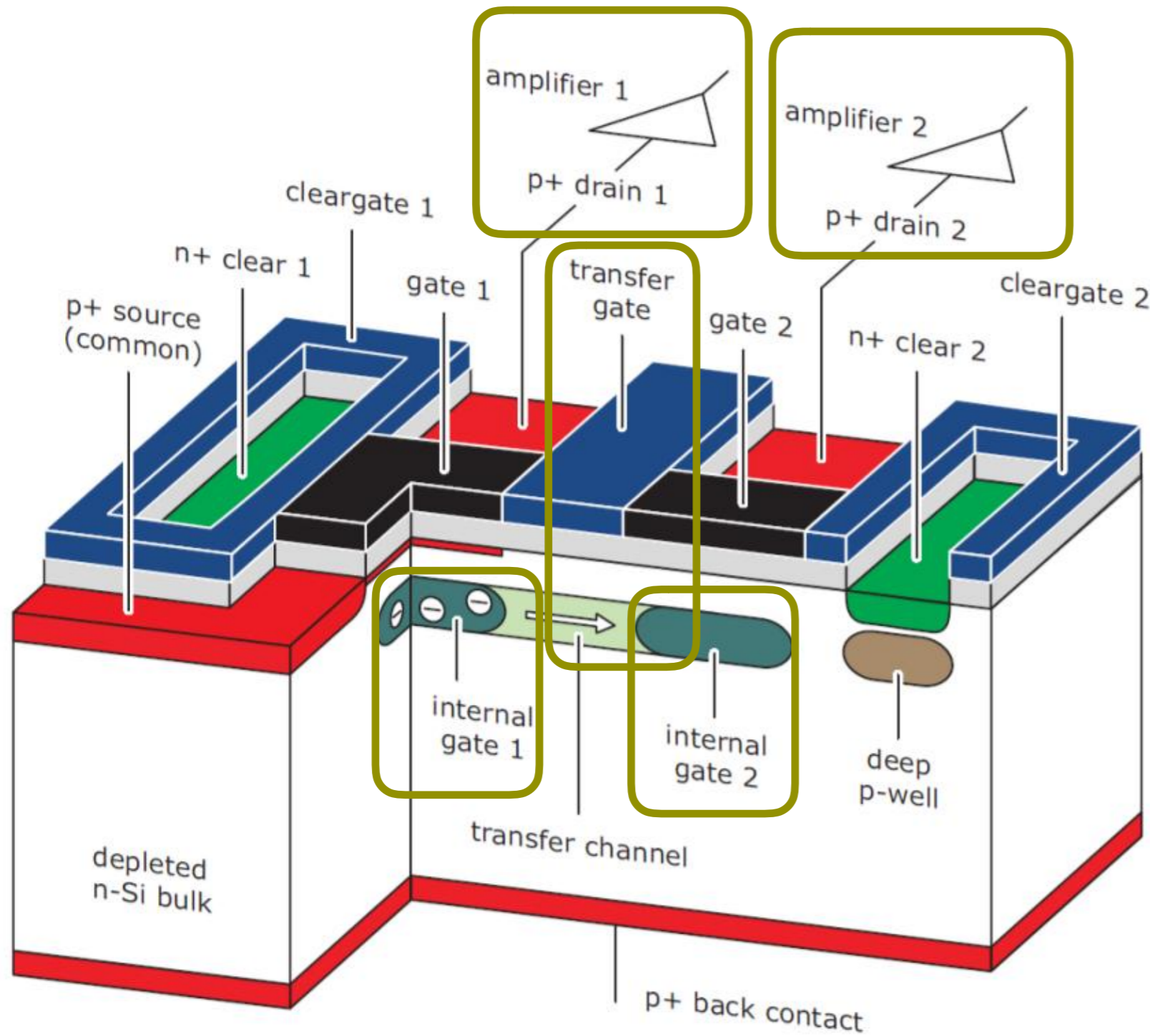


transfer gate open

read N times effective noise :

$$\sigma_{\text{eff}} = \sigma / (\sqrt{N})$$

RNDR



EPJ C, 77(12), 279 (2017)

RNDR readout

read 1 : noise σ



transfer gate open

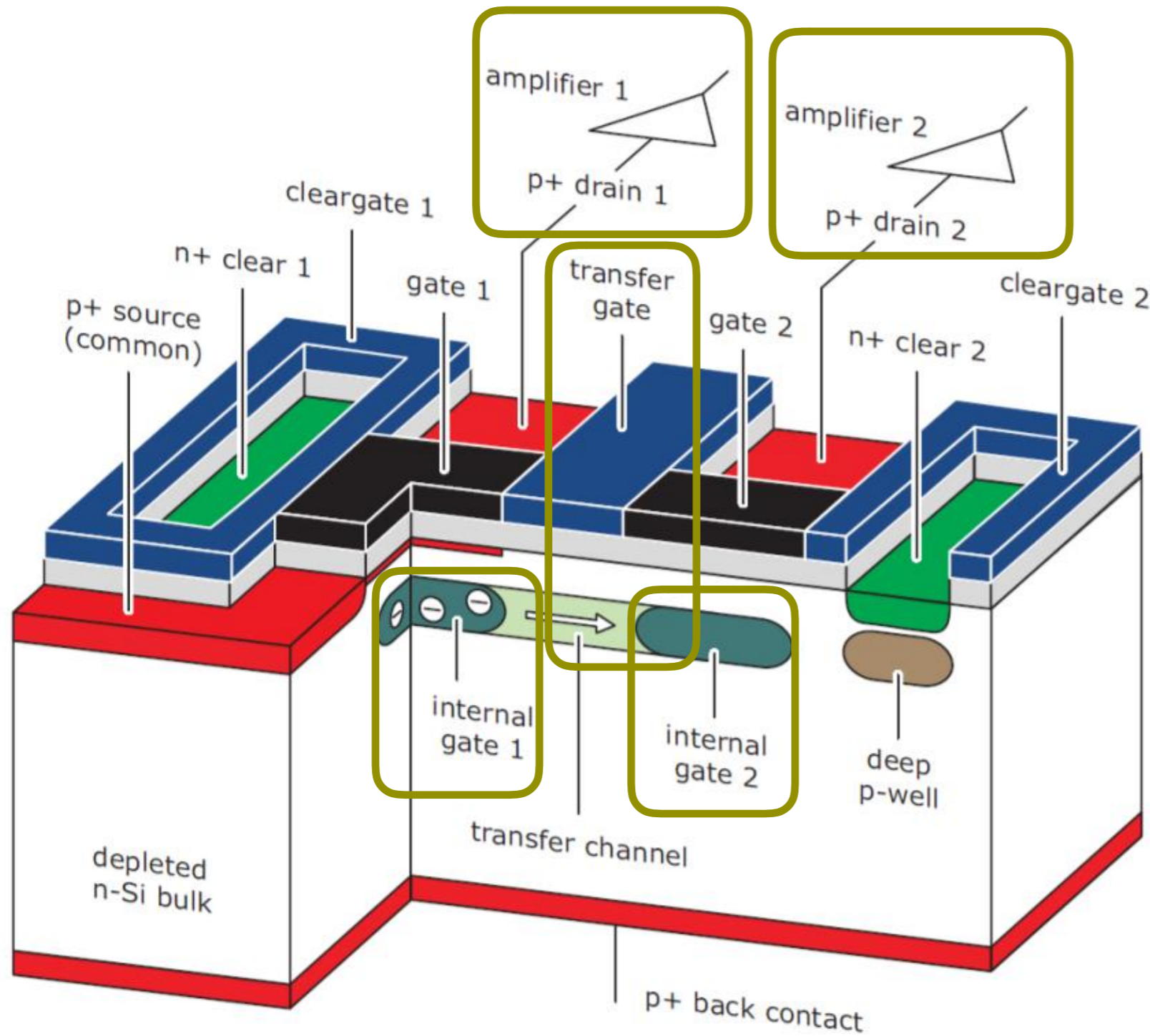


read 2 : noise σ

read N times effective noise :

$$\sigma_{\text{eff}} = \sigma / (\sqrt{N})$$

RNDR



EPJ C, 77(12), 279 (2017)

RNDR readout

read 1 : noise σ



transfer gate open



read 2 : noise σ

: repeat N times
independent
measurements



clear charges

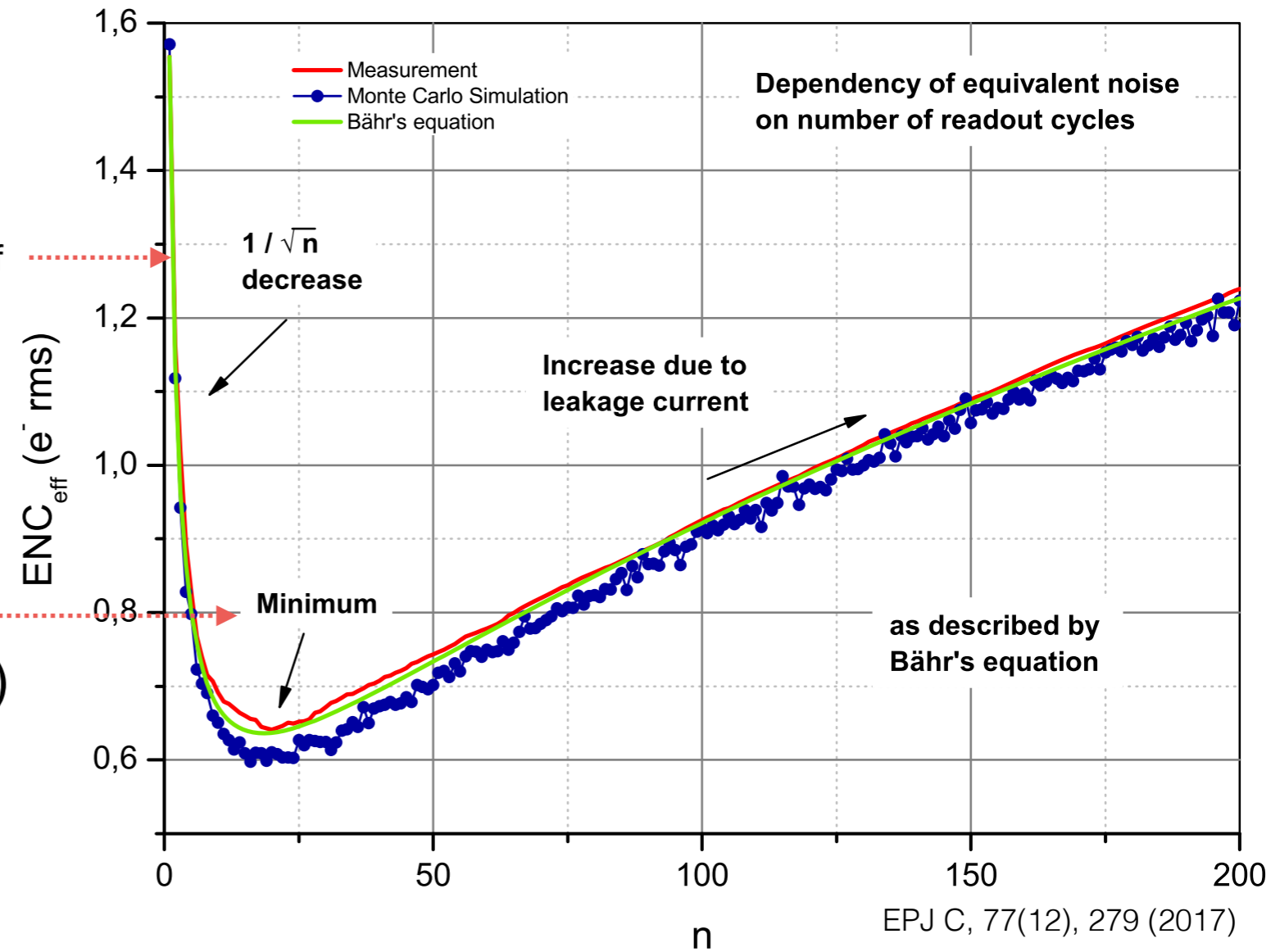
read N times effective noise :

$$\sigma_{\text{eff}} = \sigma / (\sqrt{N})$$

DEPFET RNDR single pixel performance

confirmed the $1/\sqrt{N}$ decrease of σ_{eff}

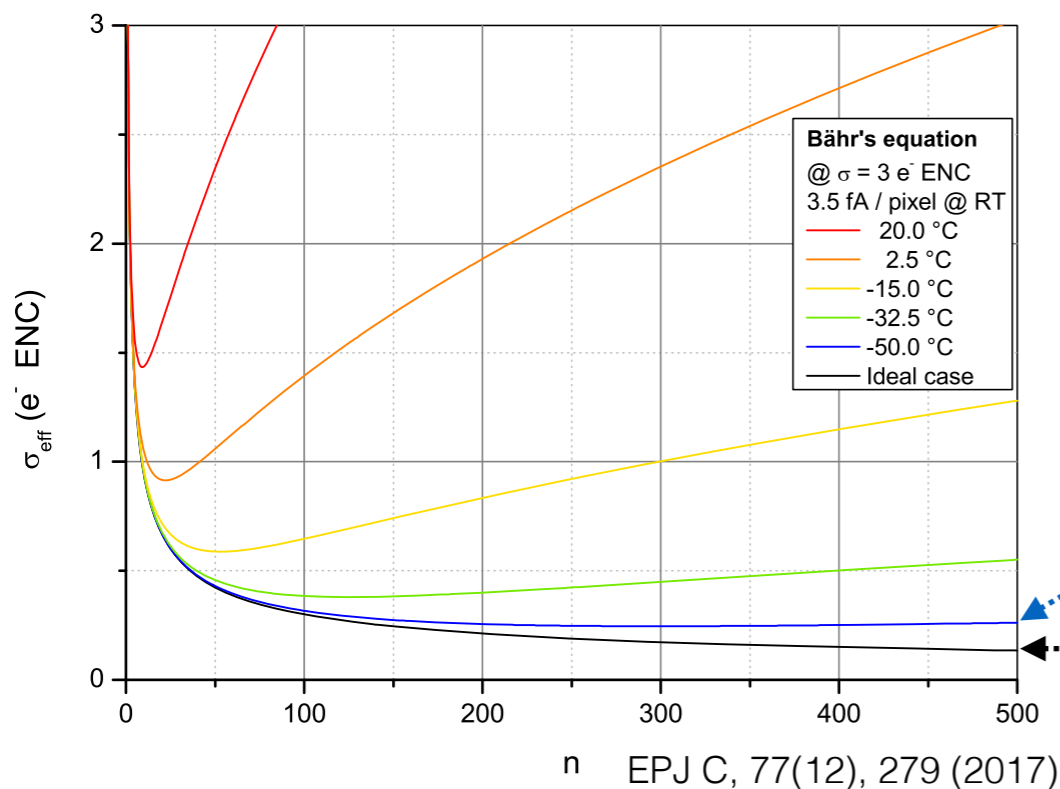
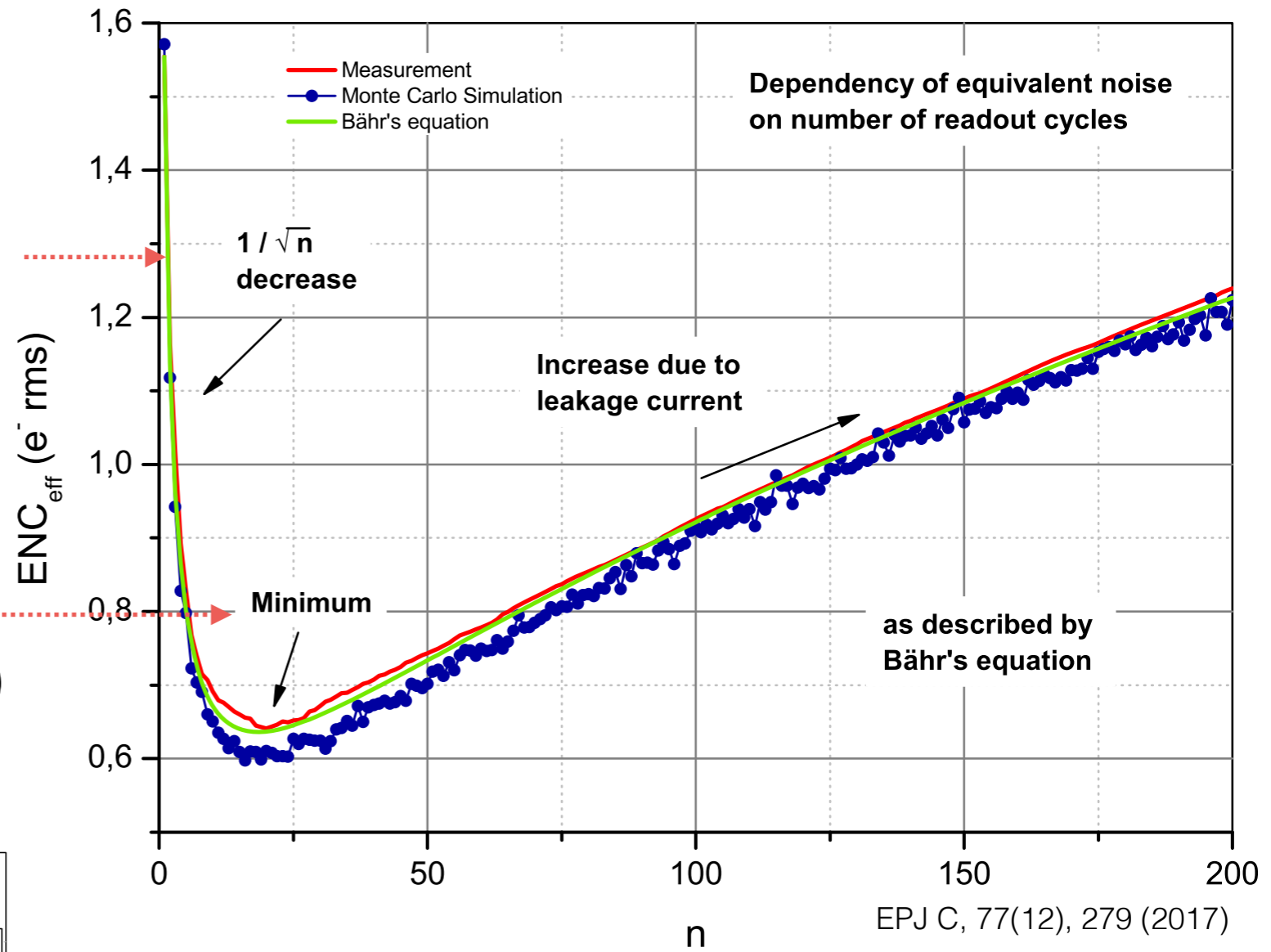
minimal noise level limited by leakage current at 230 K (-40 °C)



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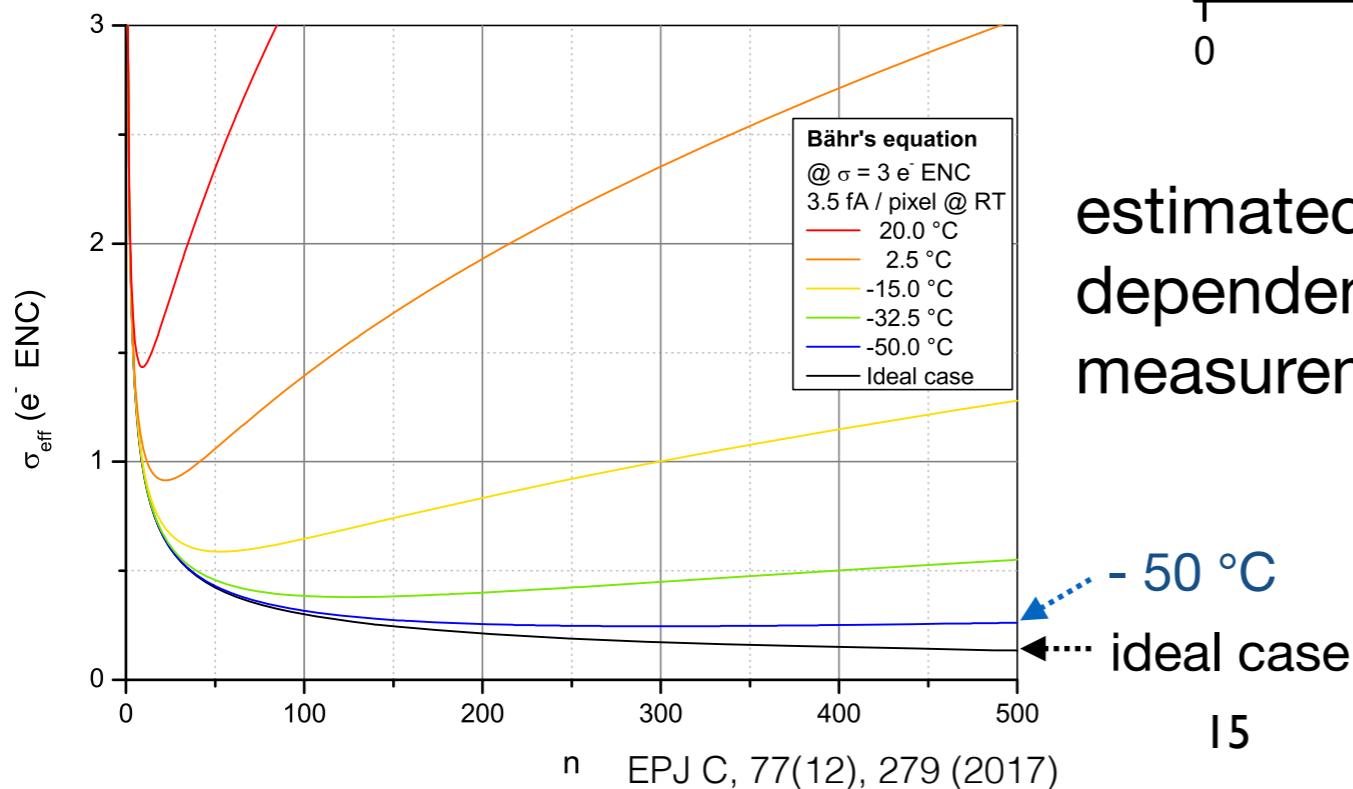
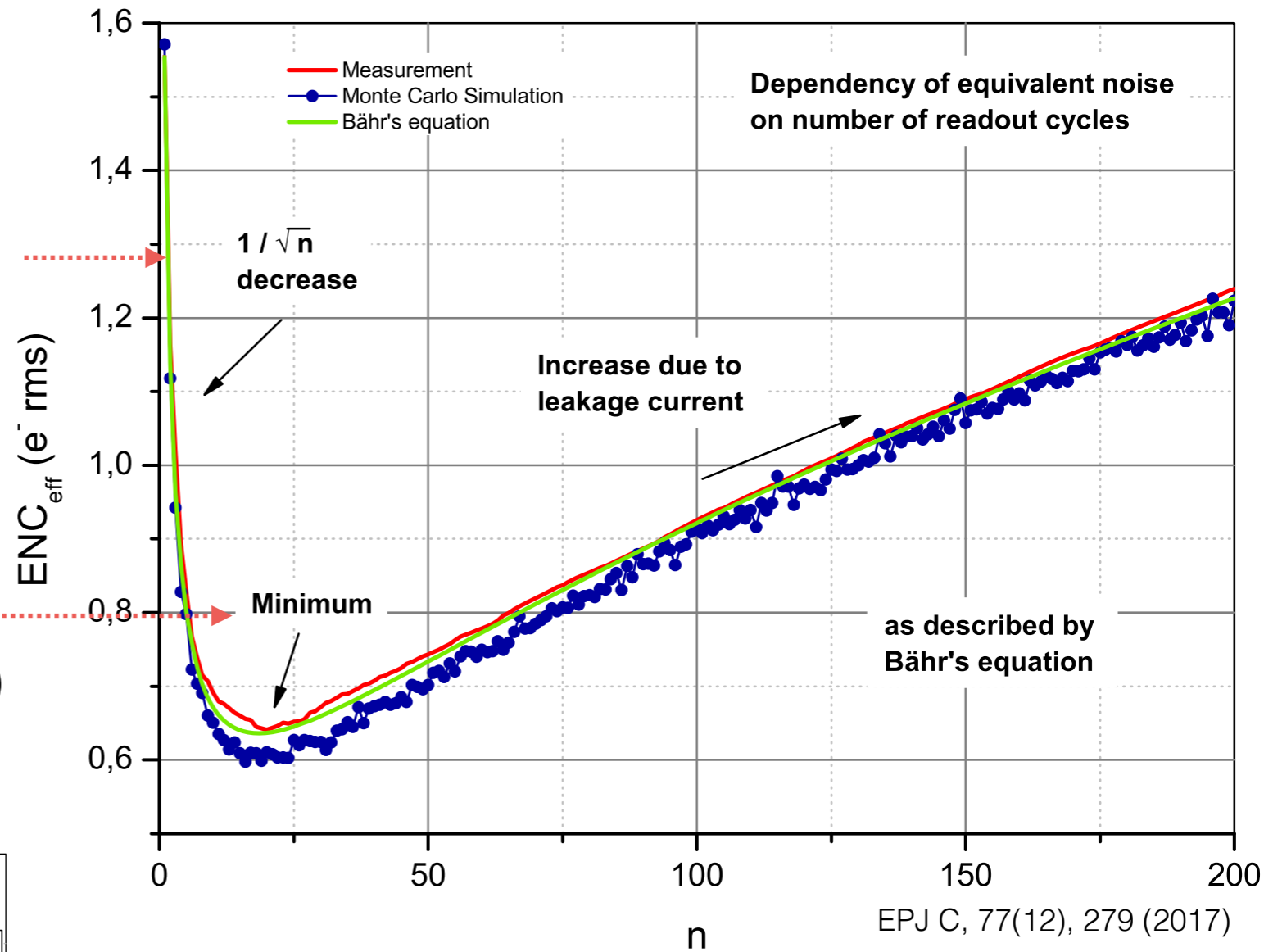
estimated temperature dependence, to be testified in measurement

- 50 °C
ideal case

DEPFET RNDR single pixel performance

confirmed the $1/\sqrt{N}$ decrease of σ_{eff}

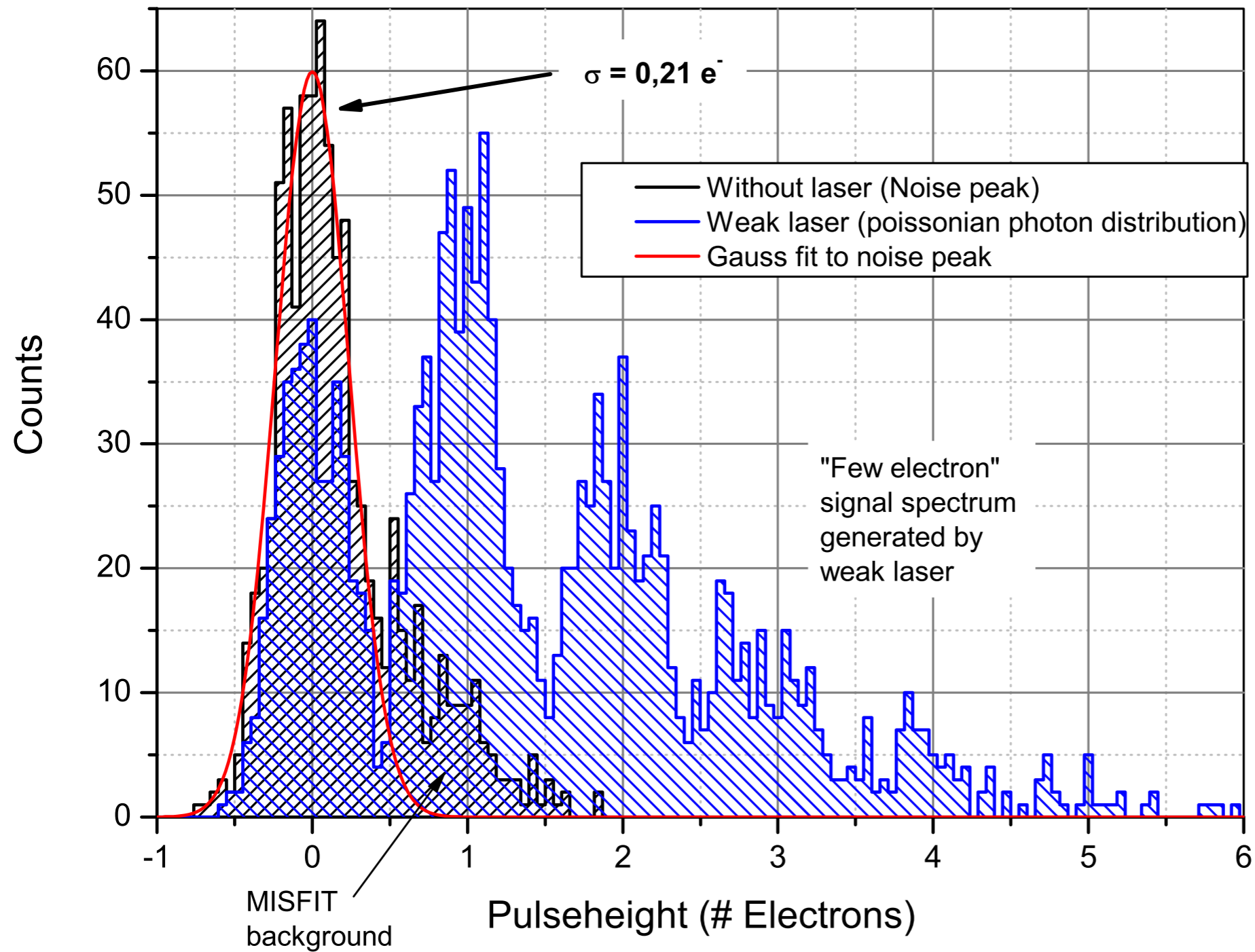
minimal noise level limited by leakage current at 230 K (-40 °C)



estimated temperature dependence, to be testified in measurement

new architecture with “blind-gate” possibility of reducing leakage current during readout

DEPFET RNDR single pixel performance



single pixel RNDR
DEPFET effective noise :
0.2 e^- RMS at 200 K

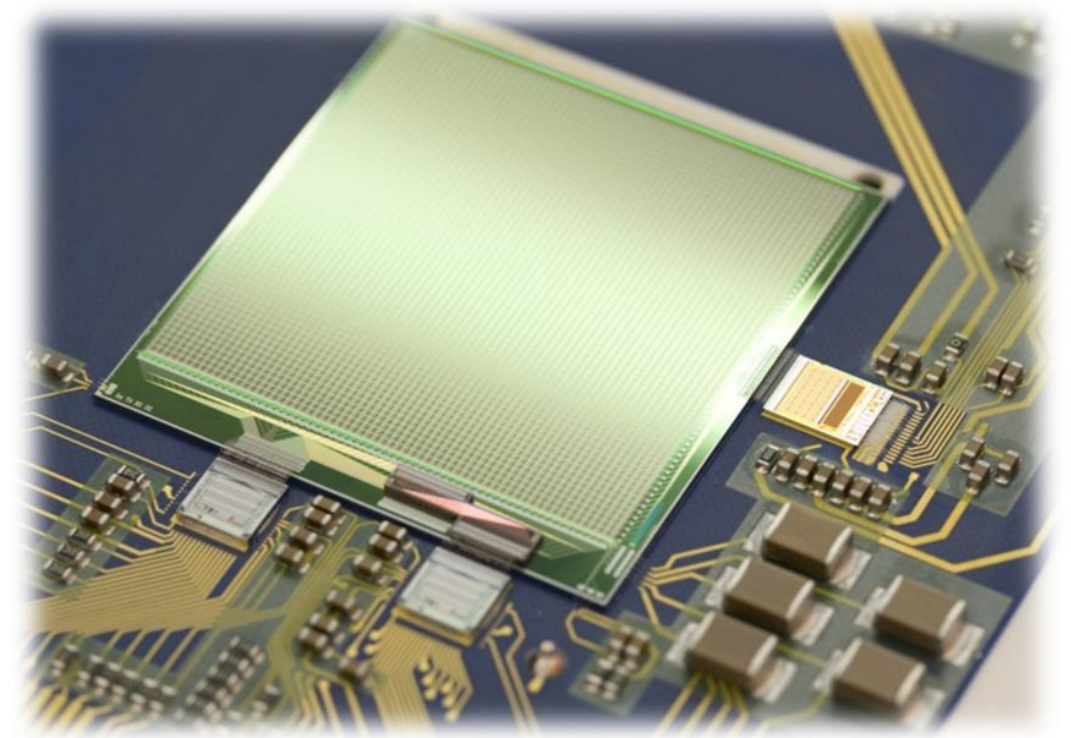
A comparison with skipper CCD

Type	Pixel format [μm]	prototype mass	operating temp	dark current	readout time (1 sample)	readout noise (optimal)
skipper CCD	15 x 15 x 200	0.071 g	140 K	<u>~1.14</u> e ⁻ /pix/day	10 μs/pix/ amplifier	0.068 e-rms/pix
RNDR DEPFET	75 x 75 x 450	0.024 g	≈ 200 K	<u>≤ 1</u> e ⁻ /pix/day	4 μs/ 64 pix	0.2 e-rms/pix

similar concepts of non-destructive readout, compatible performance;
different architecture, different systematics;
-> good complementary from experimental point of view

DANAE proof-of-principle measurement

proto-type :
75 μm x 75 μm x 450 μm single pixel,
64 x 64 matrix
sensitive volume **0.024 g**



Detector prototype at HLL-MPG
courtesy of J. Treis

At HLL :

matrix readout

optimization for operational/readout parameters

temperature dependence of leakage current

In Vienna:

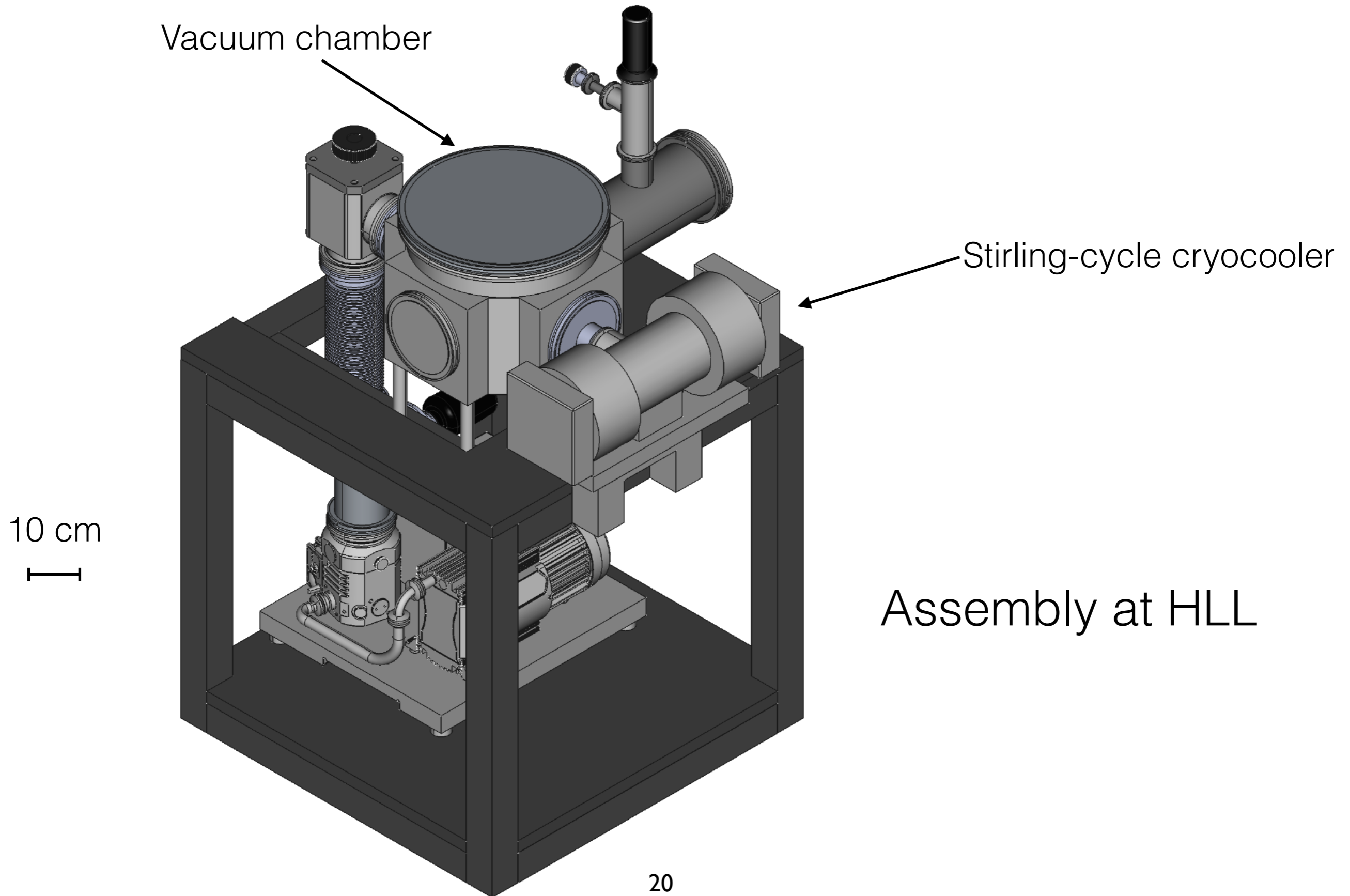
low background environment measurement
or surface measurement with veto

MC simulation for background budget

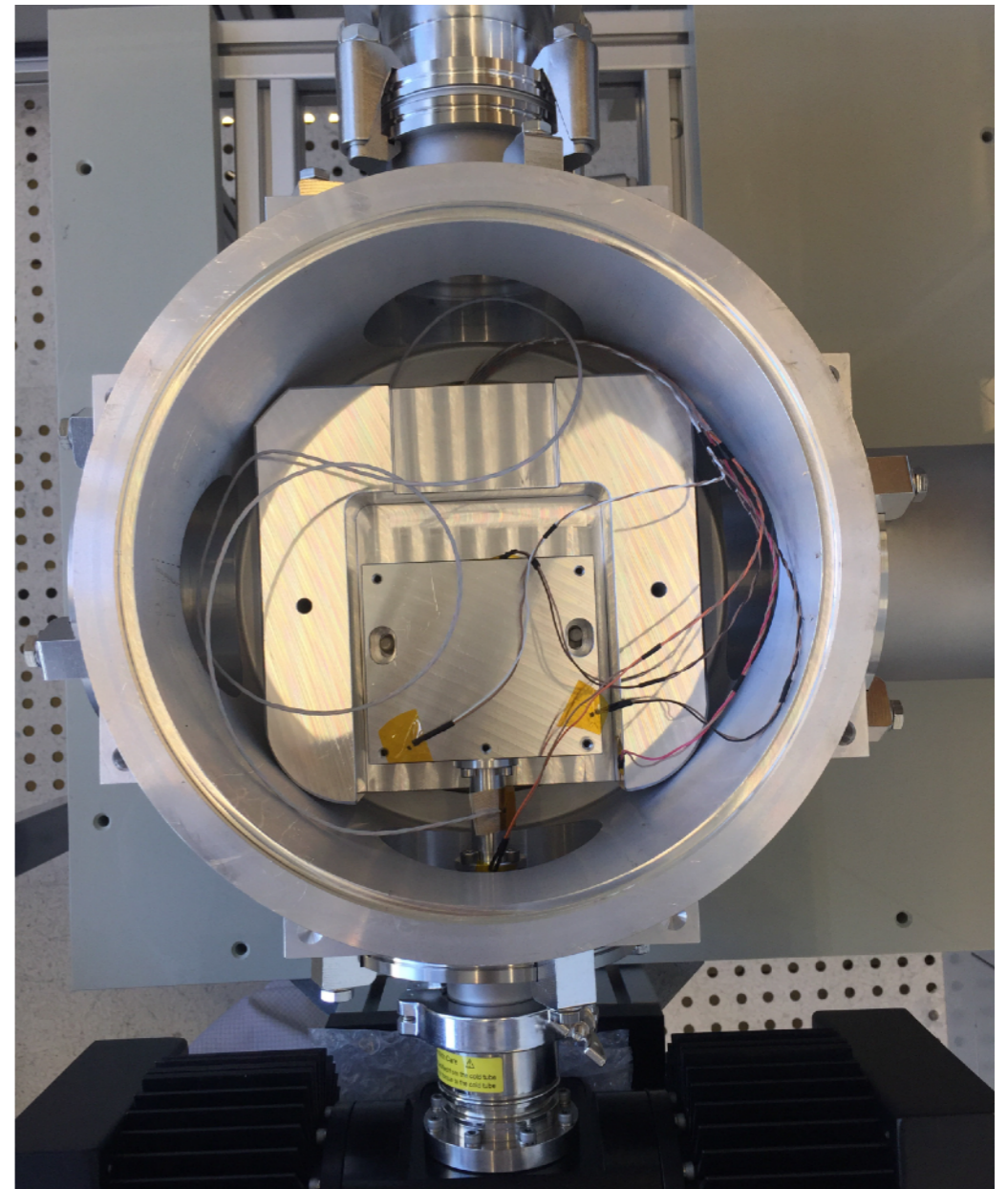
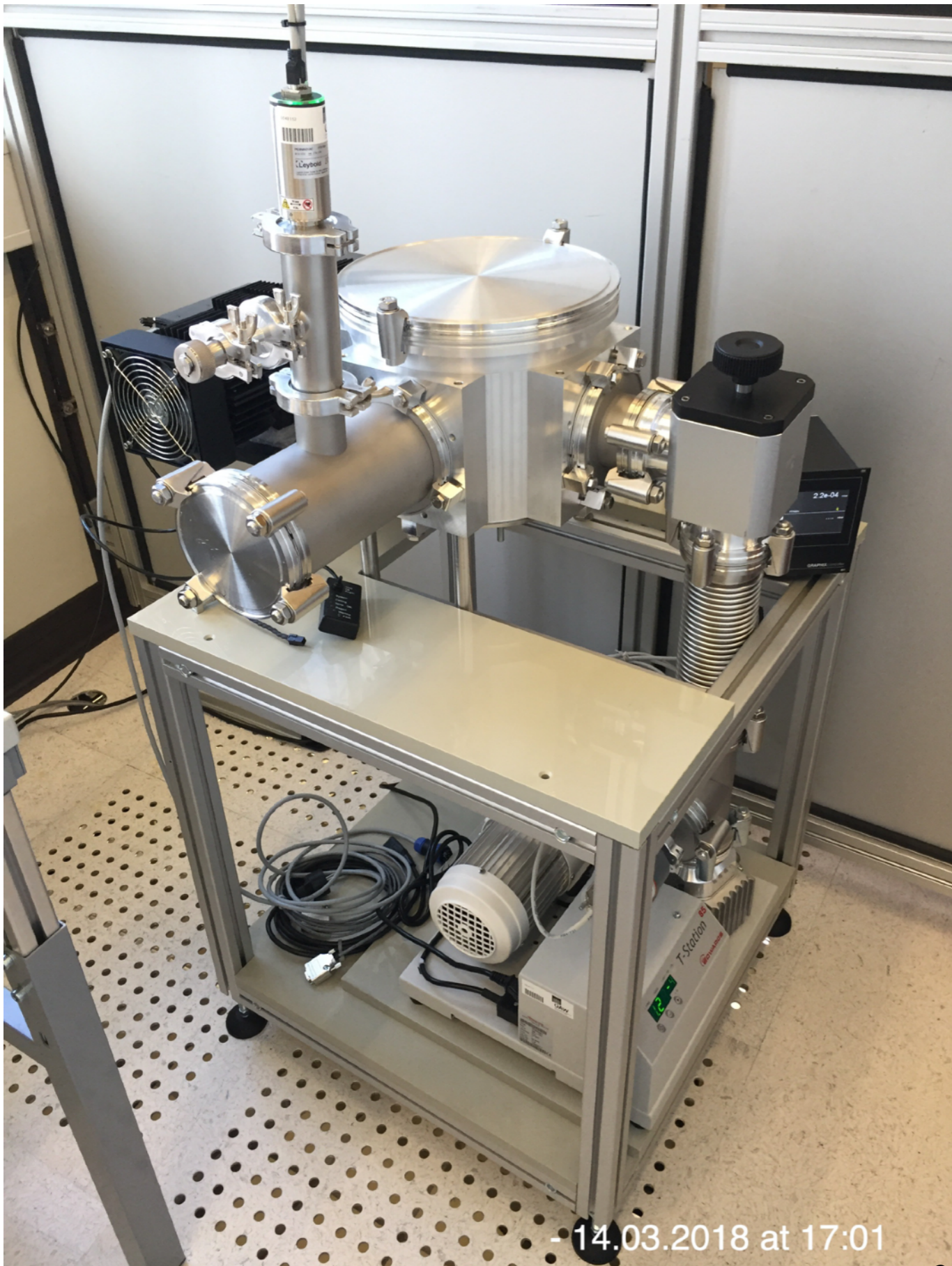
Expect to have operating
matrix by the second half
of 2018

DANAE preparation status

DANAE test setup - design image



Setup at HLL

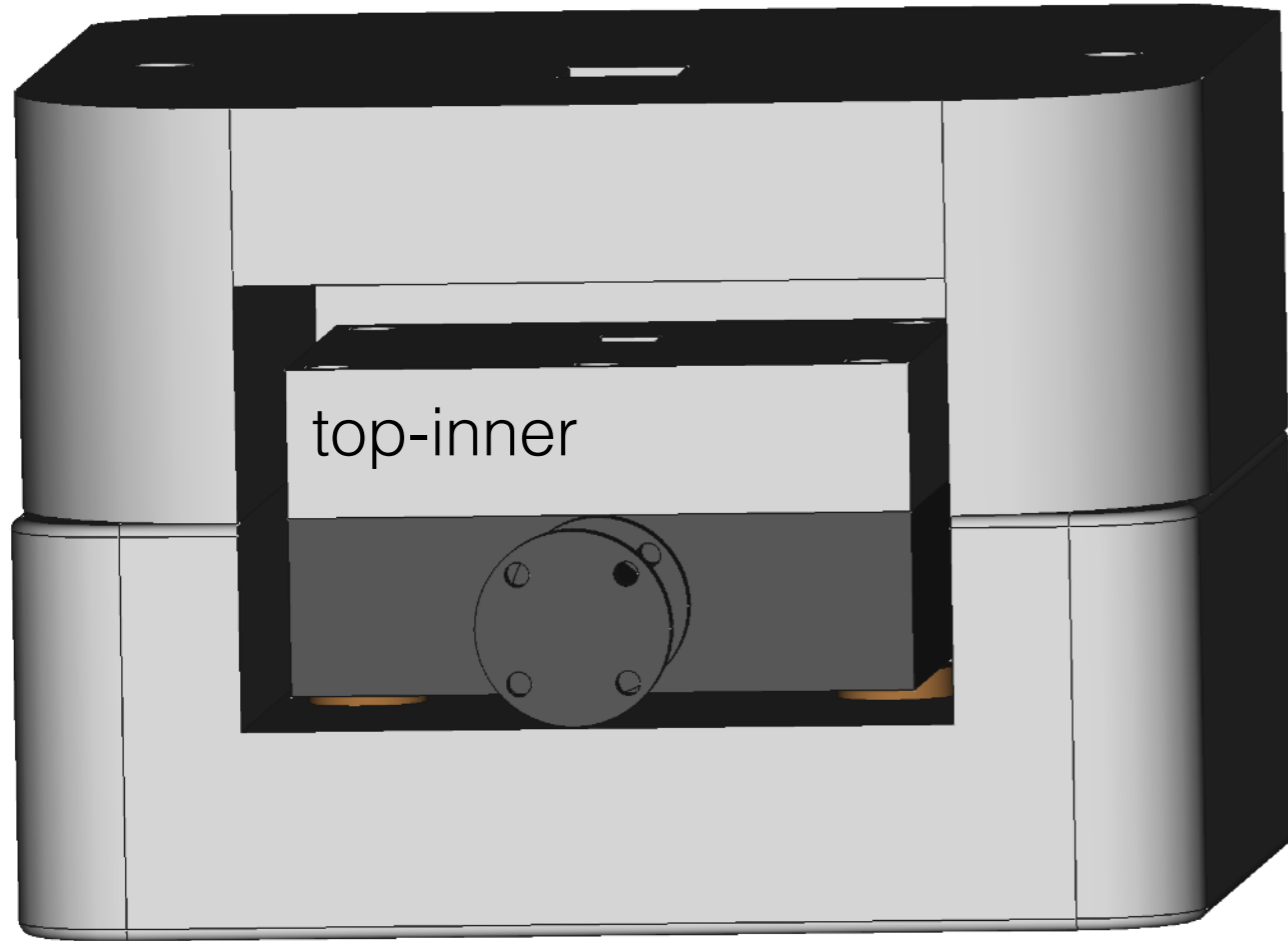


Vacuum and cooling tests
done in March 2018

cooling pad reached 150 K

Cooling & shielding layout

top-out

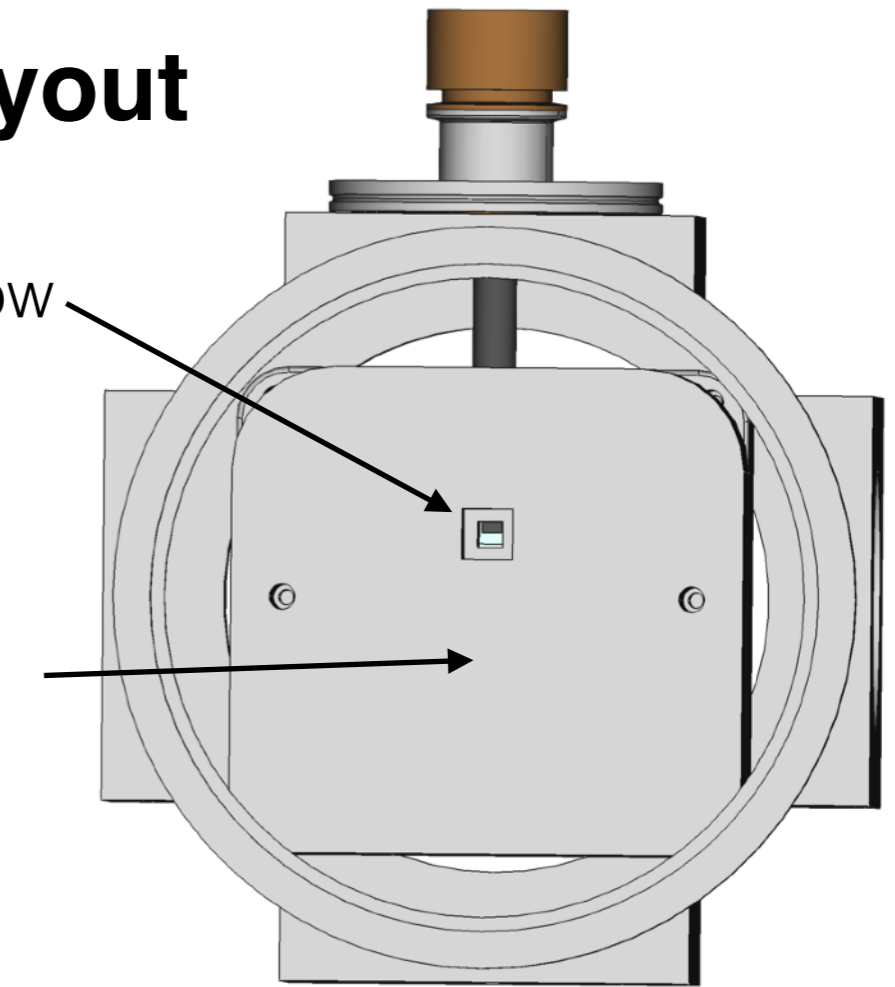


bot-out

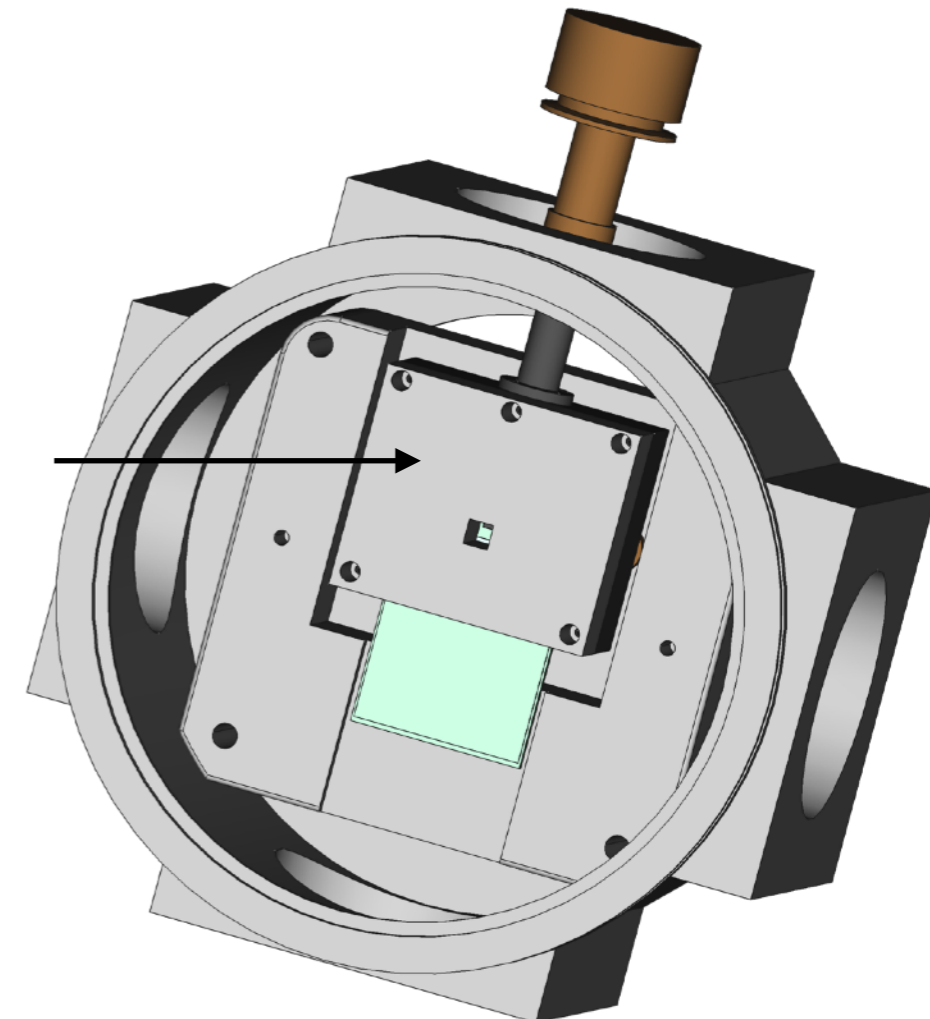
outer shielding : support structure
inner shielding : cooling contact

window

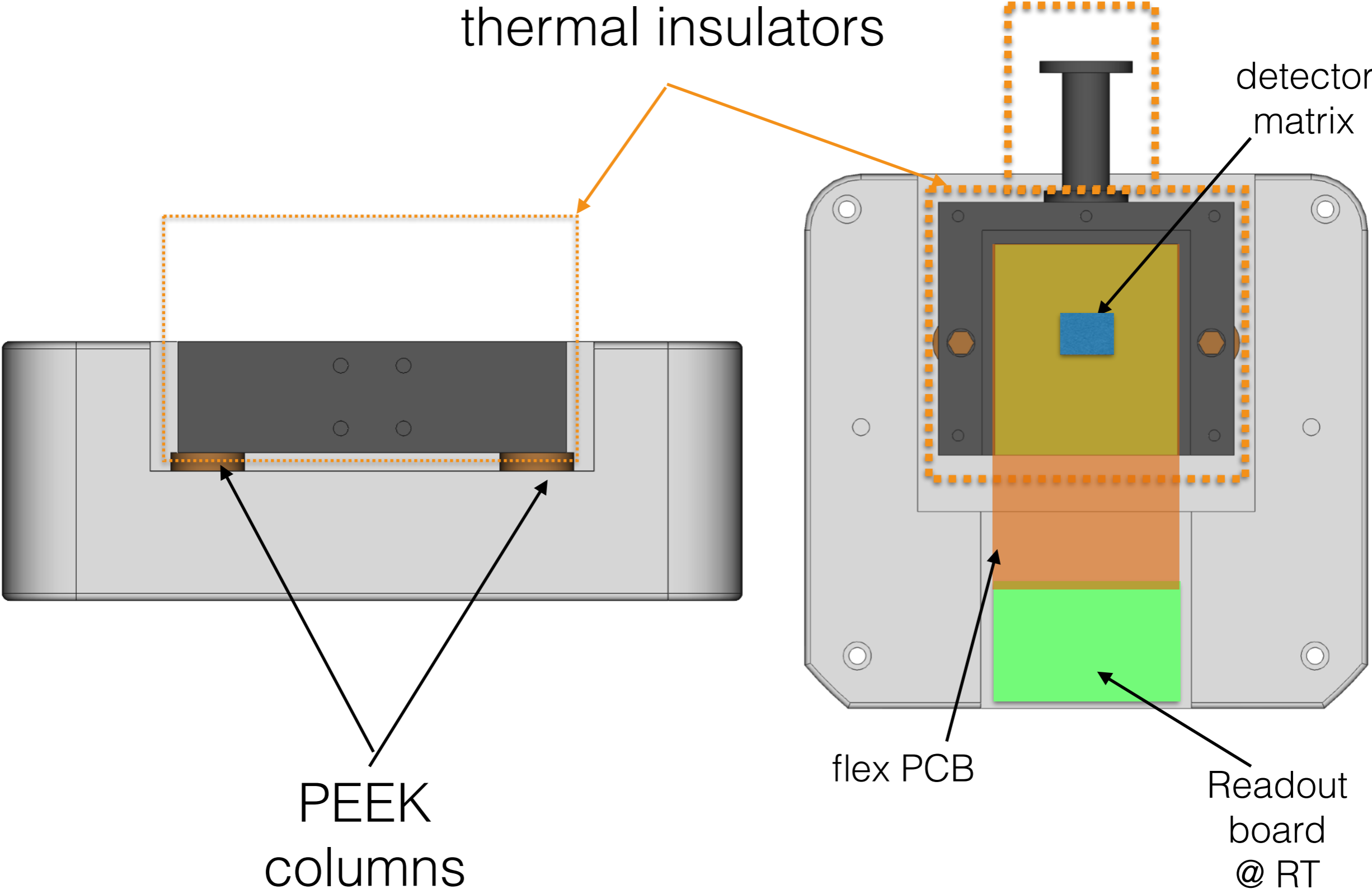
top out



top inner



Cooling of the detector and electronics



Readout electronics

Detector matrix

Front-end ASICS for the 64x64 matrix
with interface to Switcher-S, VERITAS

Switcher-S

64x2 channel analog multiplexer

Readout board

switcher id	W	N	E
function	Gate 1 & 2	Gate common	clear & transfer gate
Voltage [V]	-2.5 ~ + 5	-0.5 ~ +20	-0.5 ~ + 20/25

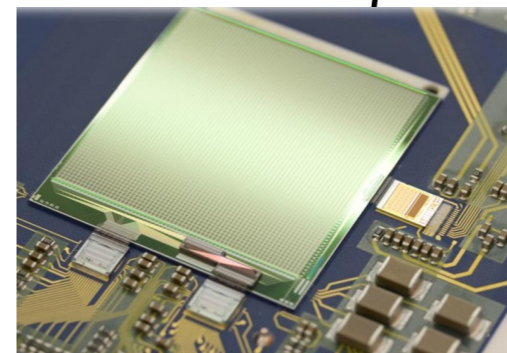
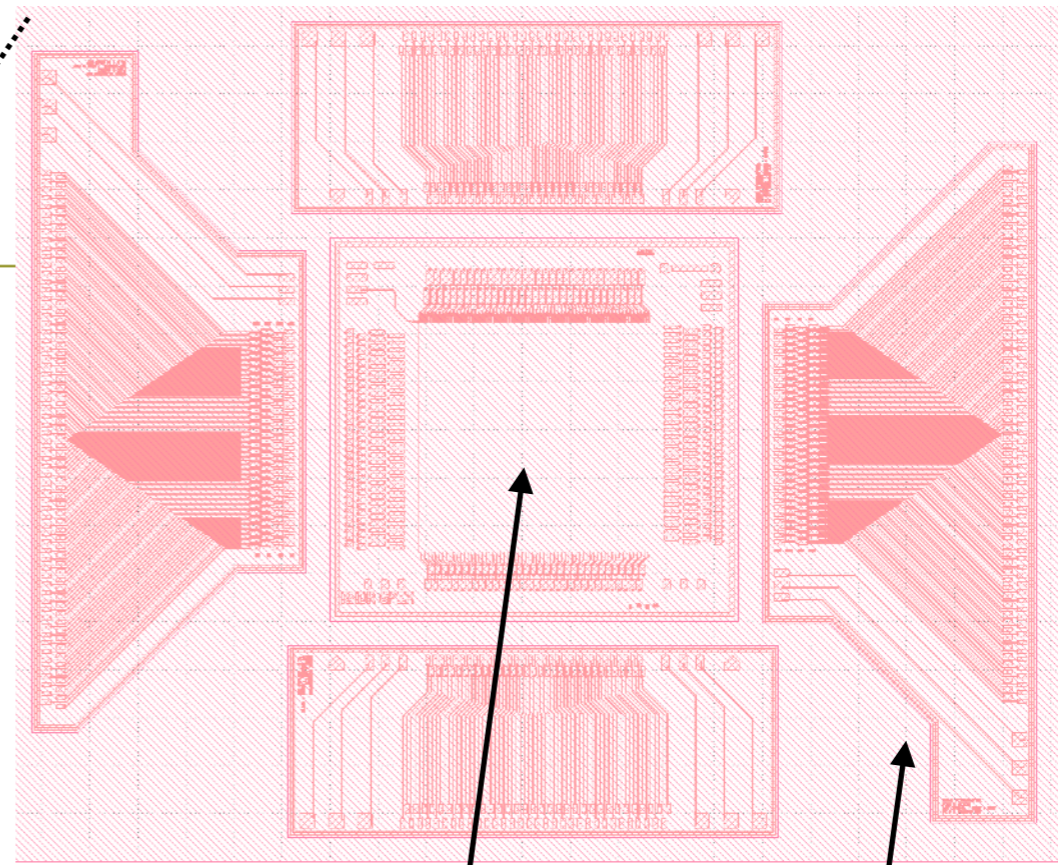
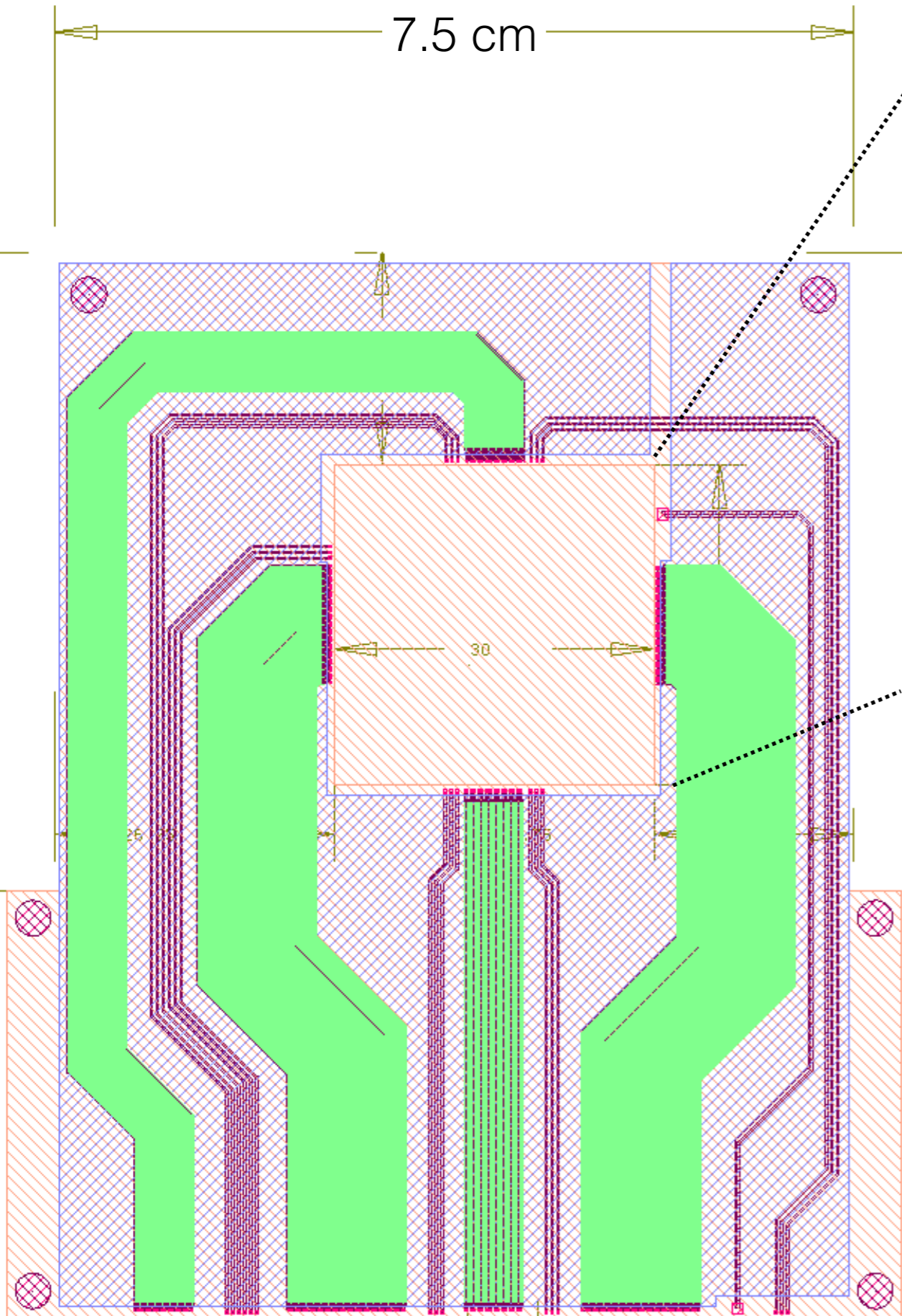
VERITAS

- VERITAS 2 ASIC in the AMS 0.35 μm CMOS 3.3 V technology
- 64 analog readout channels able to process in parallel the **signals coming from 64 DEPFET devices.**

ADC

FADC type digitizer

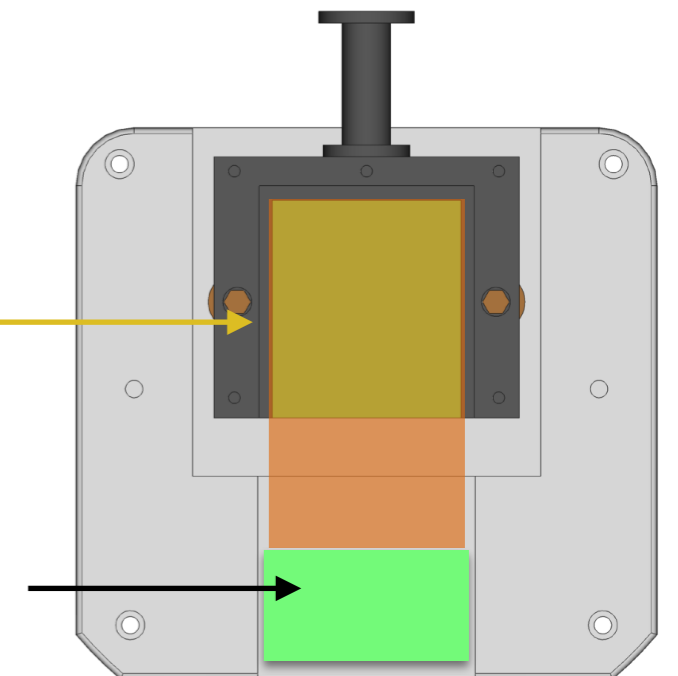
Readout electronics designs



detector matrix

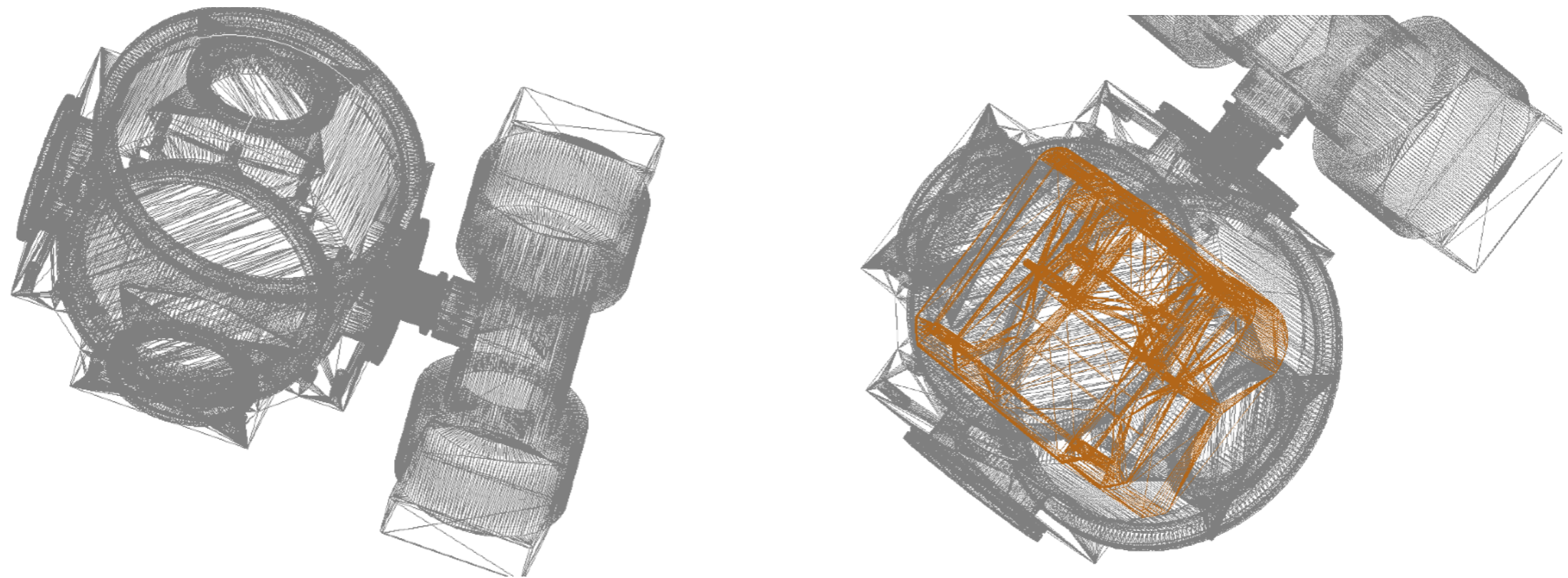
flexible PCB

Readout board



Monte Carlo simulation with Geant4

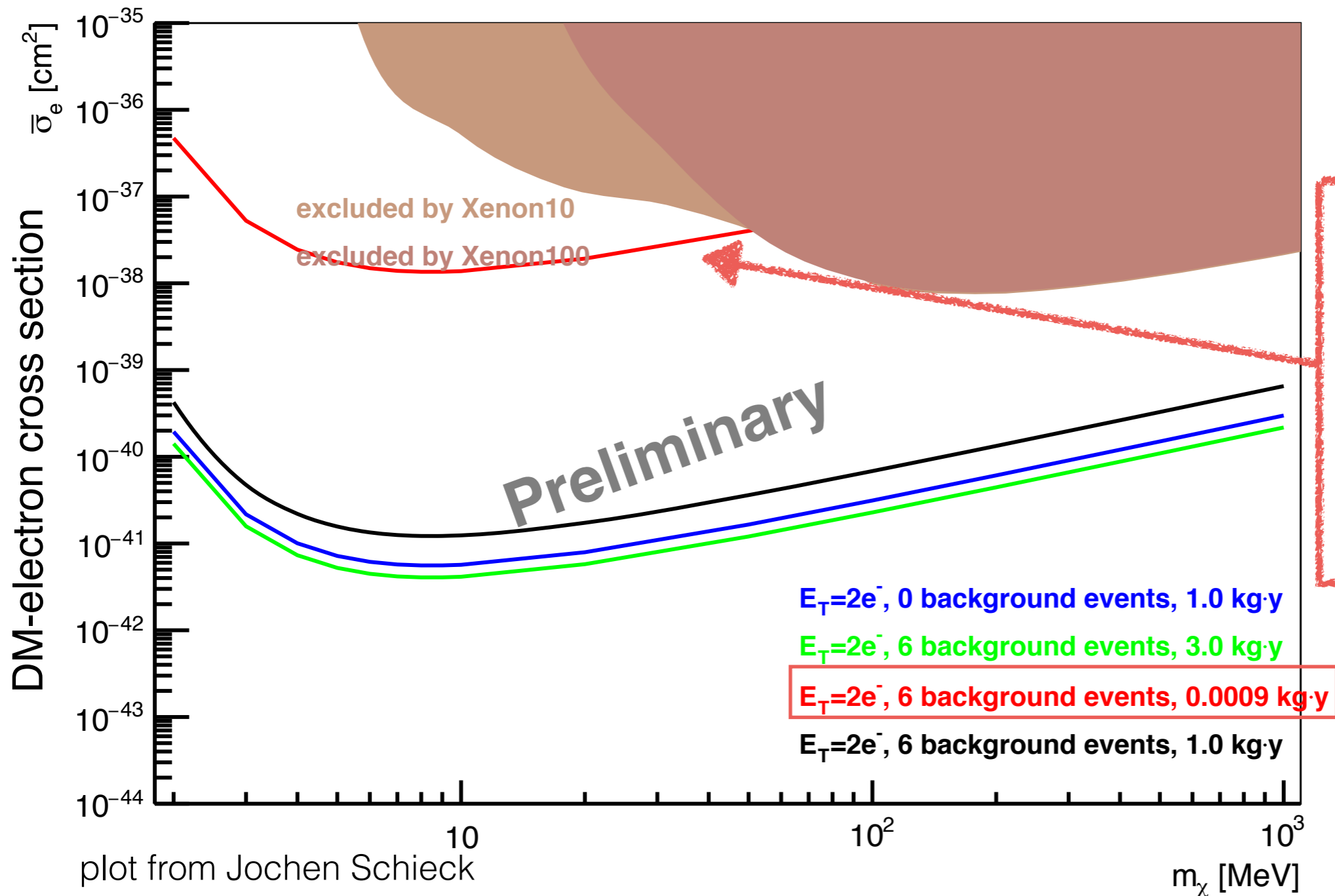
- to have a guideline of particle tracks and hit pattern, prepare the library of analysis routine;
- for future design of VETO counters and calibration layout.



- geometry of the setup from vacuum parts 3D model;
- primitive geometrical shape for DEPFET :
 - 75 μm x 75 μm x 450 μm bulk pixel, 64 by 64 matrix;
- to check response to X-rays, ambient gamma, cosmic charged particles, and neutrons;

Physics run perspective

- Expect preliminary results from the prototype setup (0.024 g sensitive volume) in late 2018
- physics run with significant result requires more matrices



physics run goal
0.9 g·y

-> 40 matrices
~1 g sensitive
volume

Summary

- sub e^- ENC low noise semiconductor detector provides the possibility to detect the energy deposit from sub-GeV DM-electron recoil;
- DANAE prototype for test-of-principle measurement with single matrix in preparation;
- one of the first generation experiments using non-destructive repetitive readout method.

Future tasks & topics

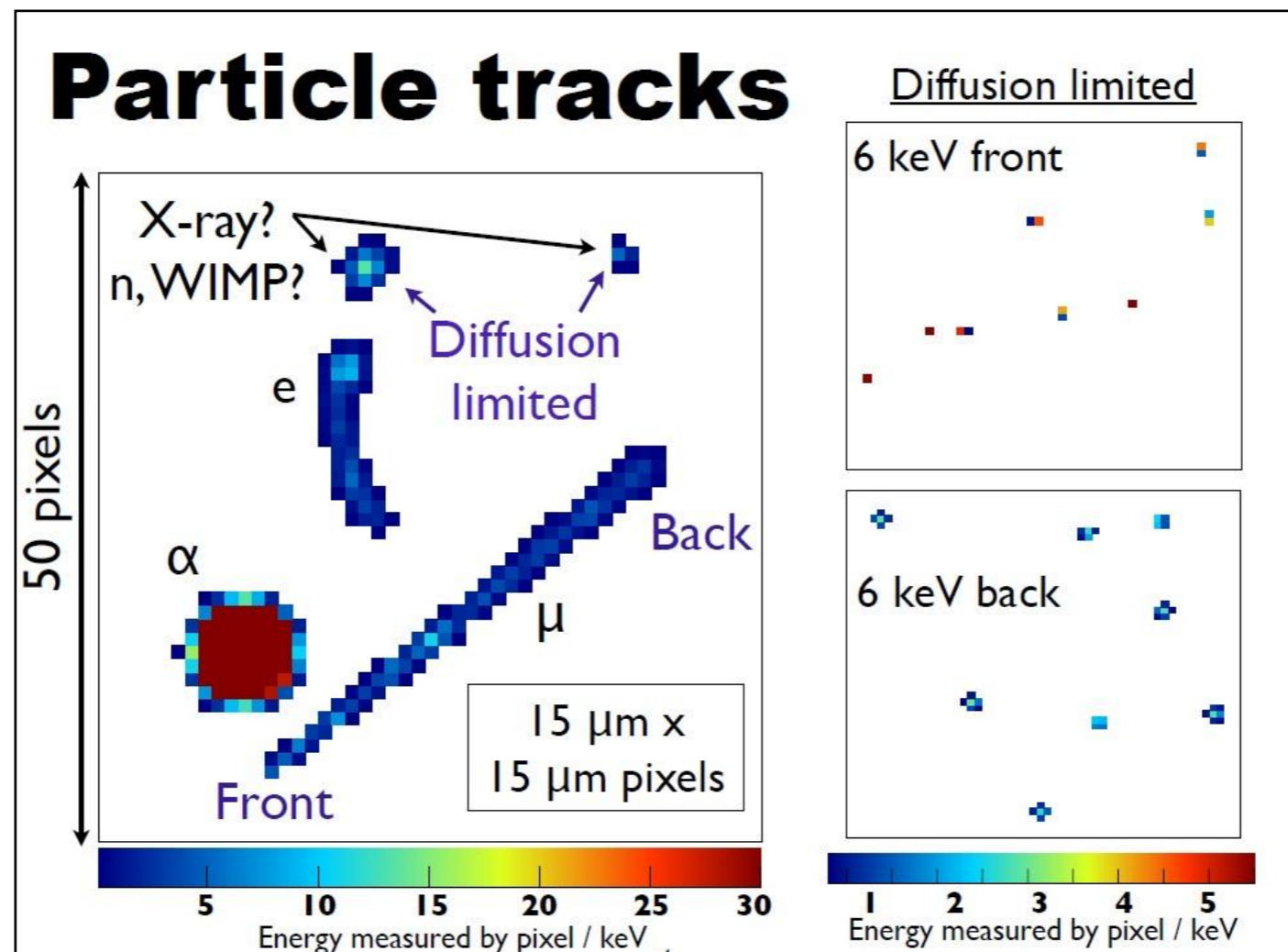
- readout electronics, DAQ in preparation;
- readout test, leakage current test;
- calibration regime and configuration;
- simulation for background;
- design for further shielding - passive and active.

Let us put DANAE into the landscape
of direct DM detection experiments!!

Hit pattern simulation with Geant4

- to have a guideline of particle tracks and hit pattern, prepare the library of analysis routine;
- for future design of VETO counters and calibration layout.

Results from DAMIC experiment

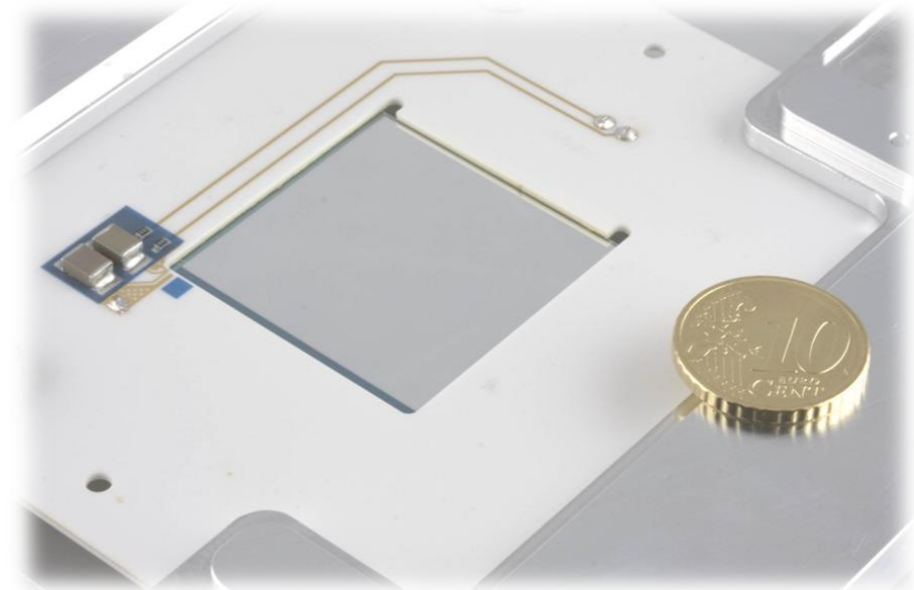
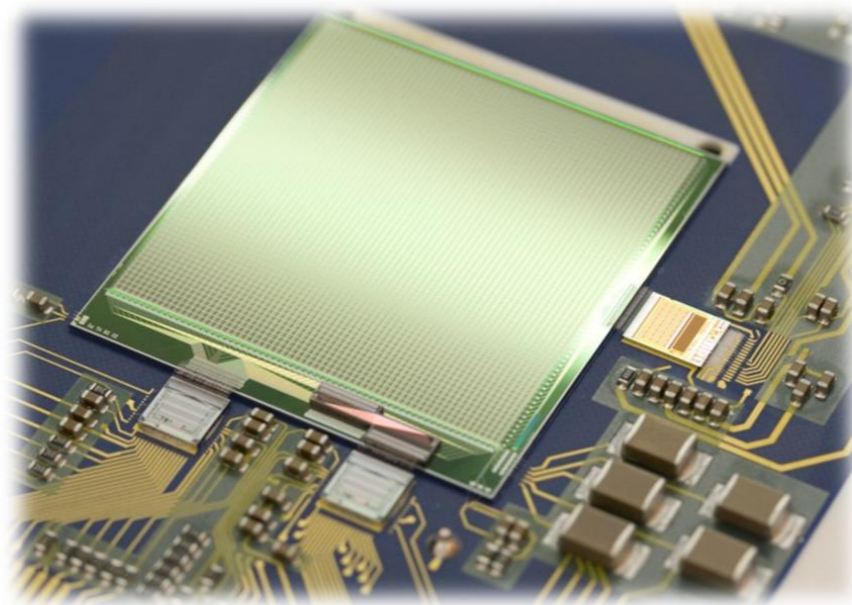
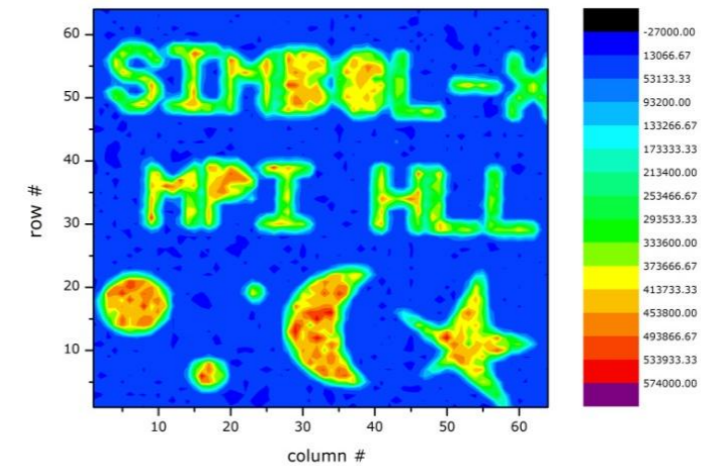


Detector Structures



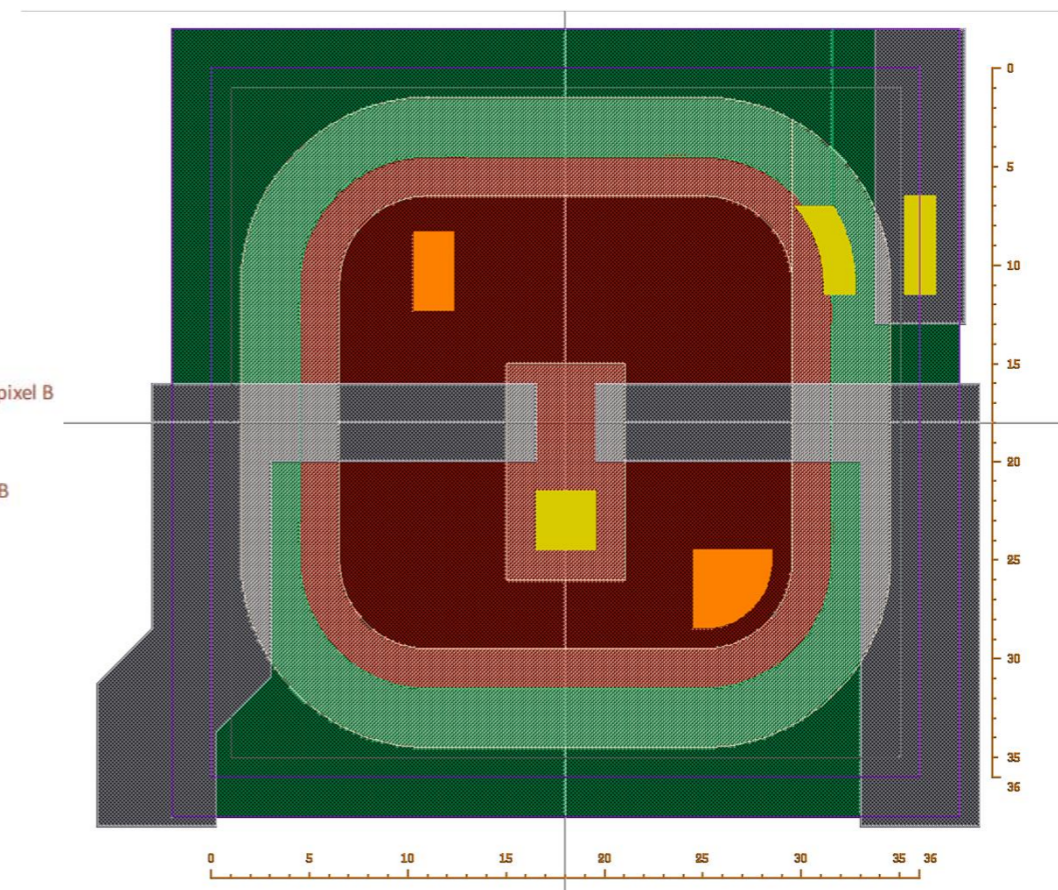
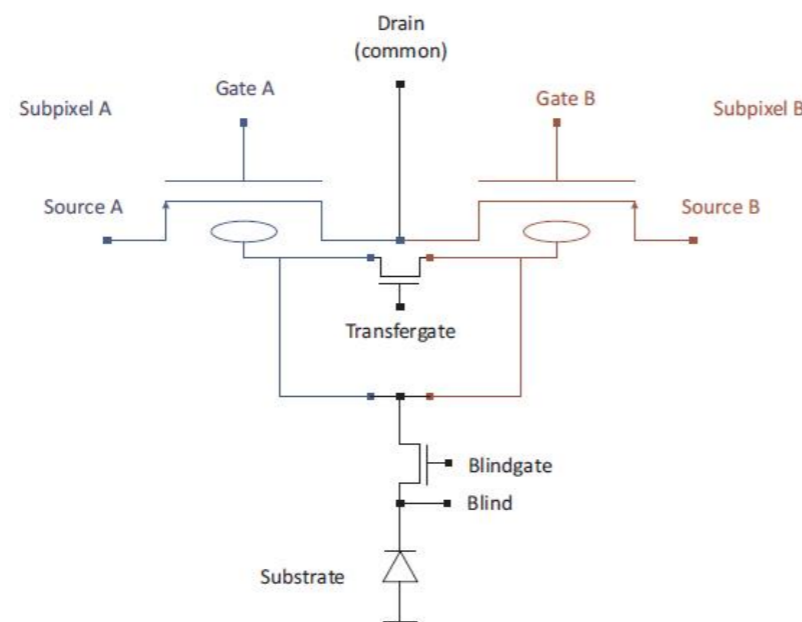
Macropixel sensors

- Prototypes
 - 64 x 64 pixels (500 μm & 300 μm)
 - 3.2 x 3.2 cm^2
 - high framerate (4 kHz)
 - near Fano-Limited energy resolution



Small pixel device layouts

- Global Clear variant
- Blinds also used for clearing
- 36 x 36 mm²

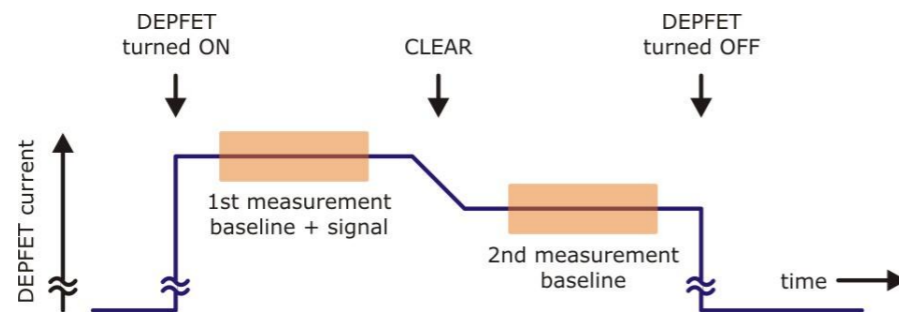


DEPFET CDS circle

Detector Structures – Matrix Devices



readout sequence



Correlated double sampling:

1st measurement: signal + baseline

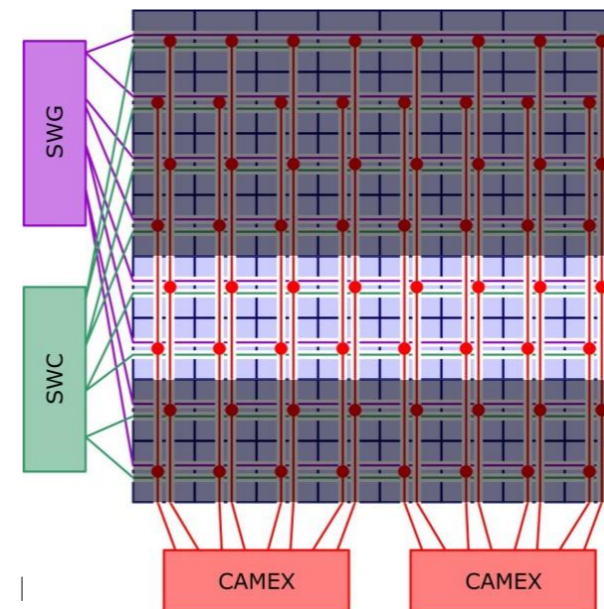
clear: removal of signal charges

2nd measurement: baseline

difference = signal

complete clear is mandatory!

matrix operation



vertical signal lines

1 active row, other pixels integrating

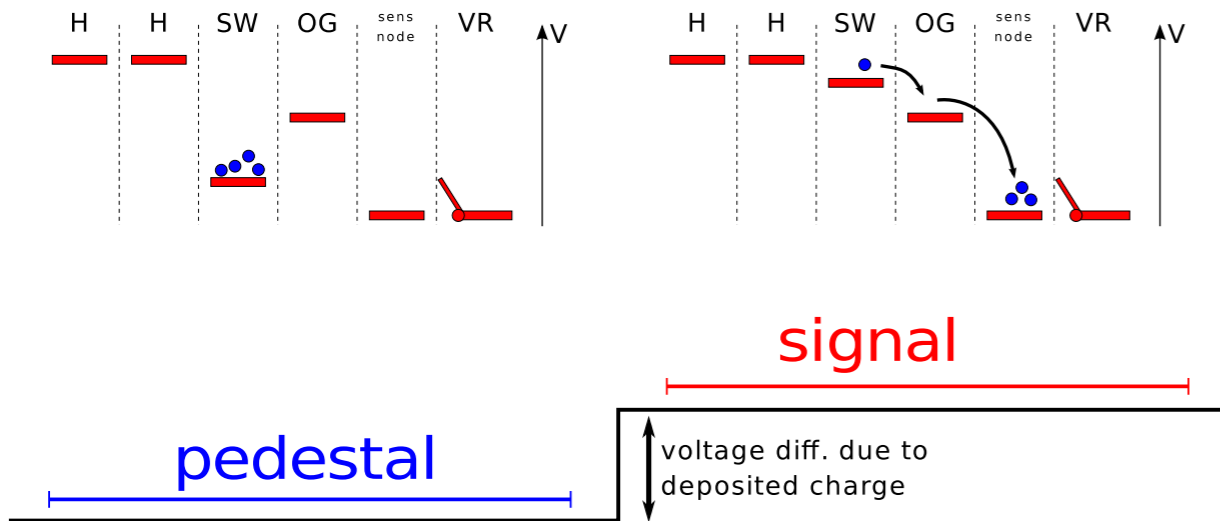
option to speed up (1)

readout parallelisation

2 x readout channels, 2 active rows

CCD (skipper) readout

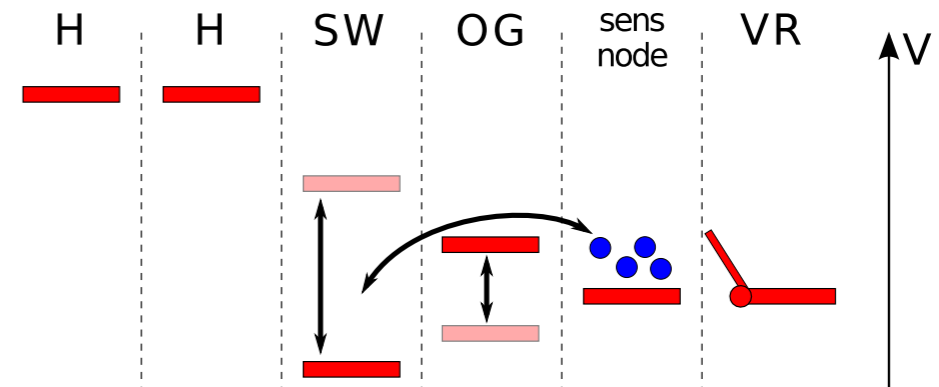
CCD: readout



Lowering the noise: Skipper CCD

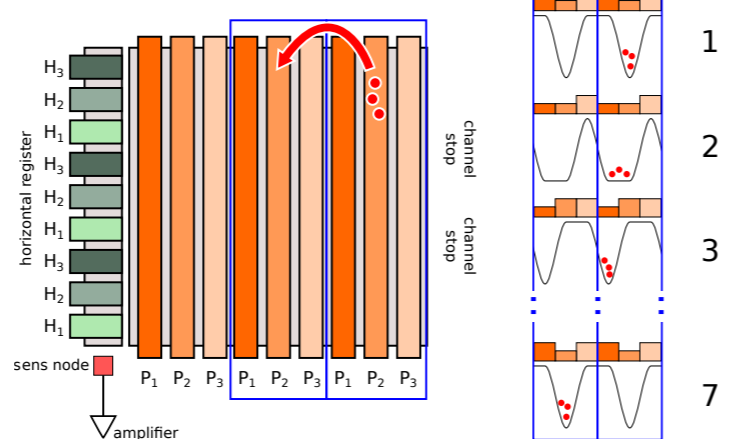
- **Main difference:** the Skipper CCD allows multiple sampling of the same pixel without corrupting the charge packet.
- The final pixel value is the average of the samples

$$\text{Pixel value} = \frac{1}{N} \sum_i^N (\text{pixel sample}_i)$$



CCD: readout

3x3 pixels CCD

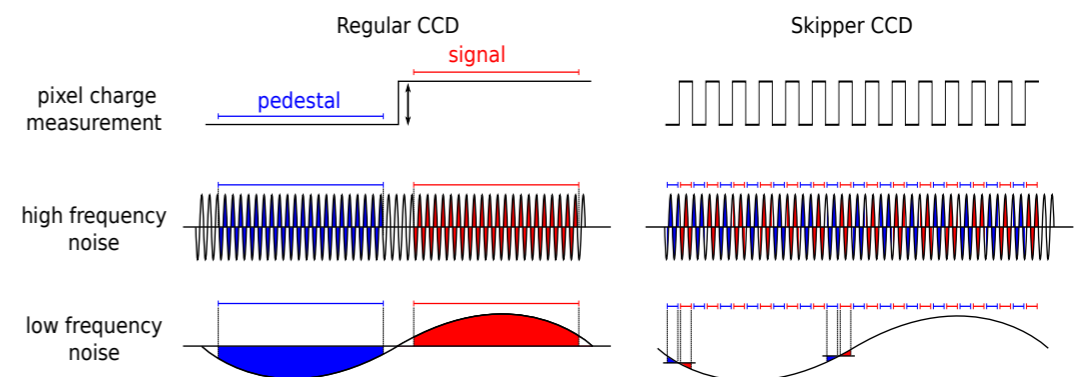


capacitance of the system is set by the SN: $C=0.05\text{pF} \rightarrow 3\mu\text{V}/e$

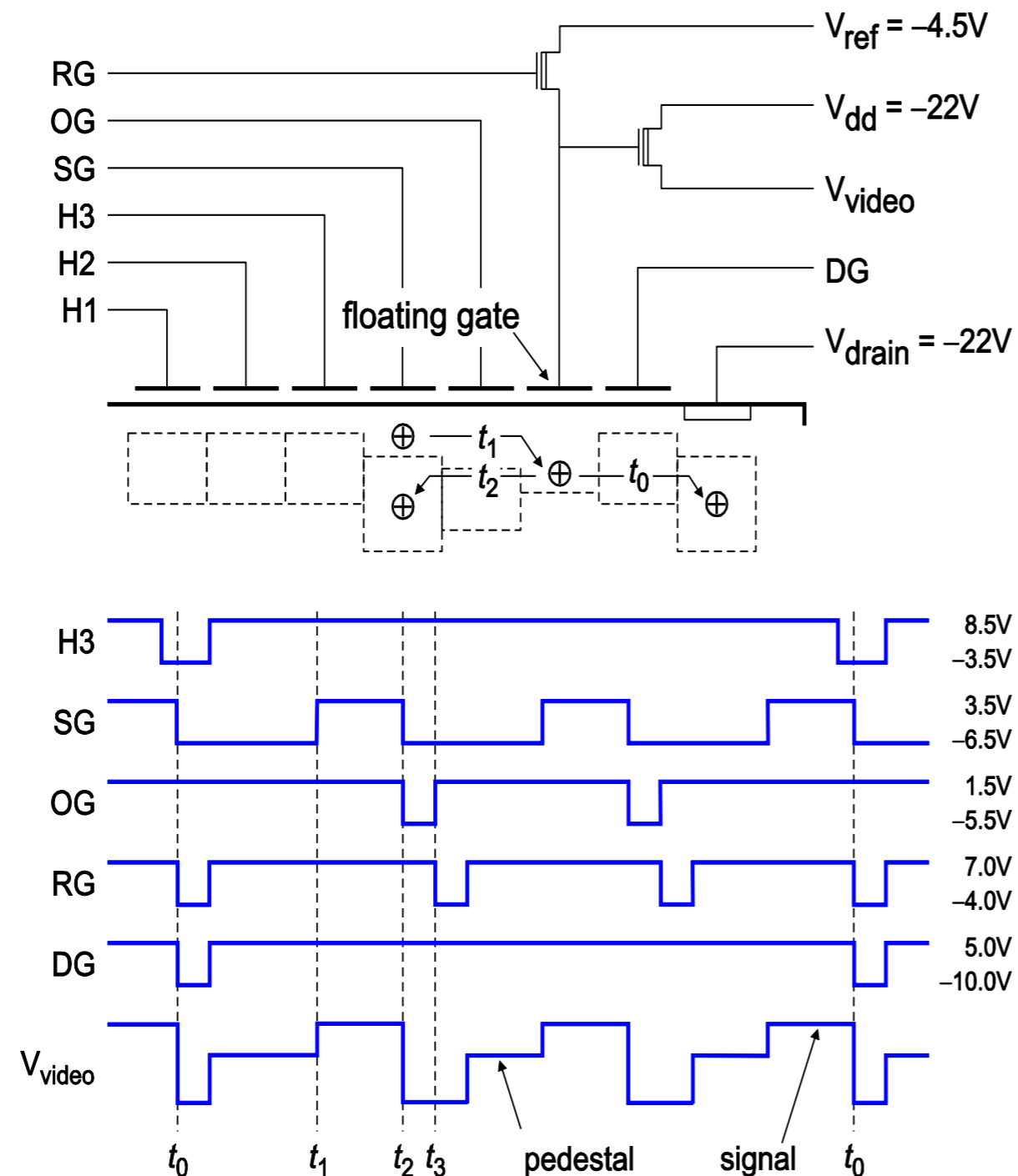
Lowering the noise: Skipper CCD

- **Main difference:** the Skipper CCD allows multiple sampling of the same pixel without corrupting the charge packet.
- The final pixel value is the average of the samples

$$\text{Pixel value} = \frac{1}{N} \sum_i^N (\text{pixel sample}_i)$$



Skipper CCD



The “skipper” allow multiple readouts of the charge in each pixel.

- Floating gate output instead of floating diffusion output used in regular CCDs.
- The charge can be moved back and forth between

Each readout integration time is kept short to make $1/f$ noise negligible.

A noise reduction of $1/\sqrt{N}$ is achieved for N reads.

The total readout time per pixel increases linearly with N .